

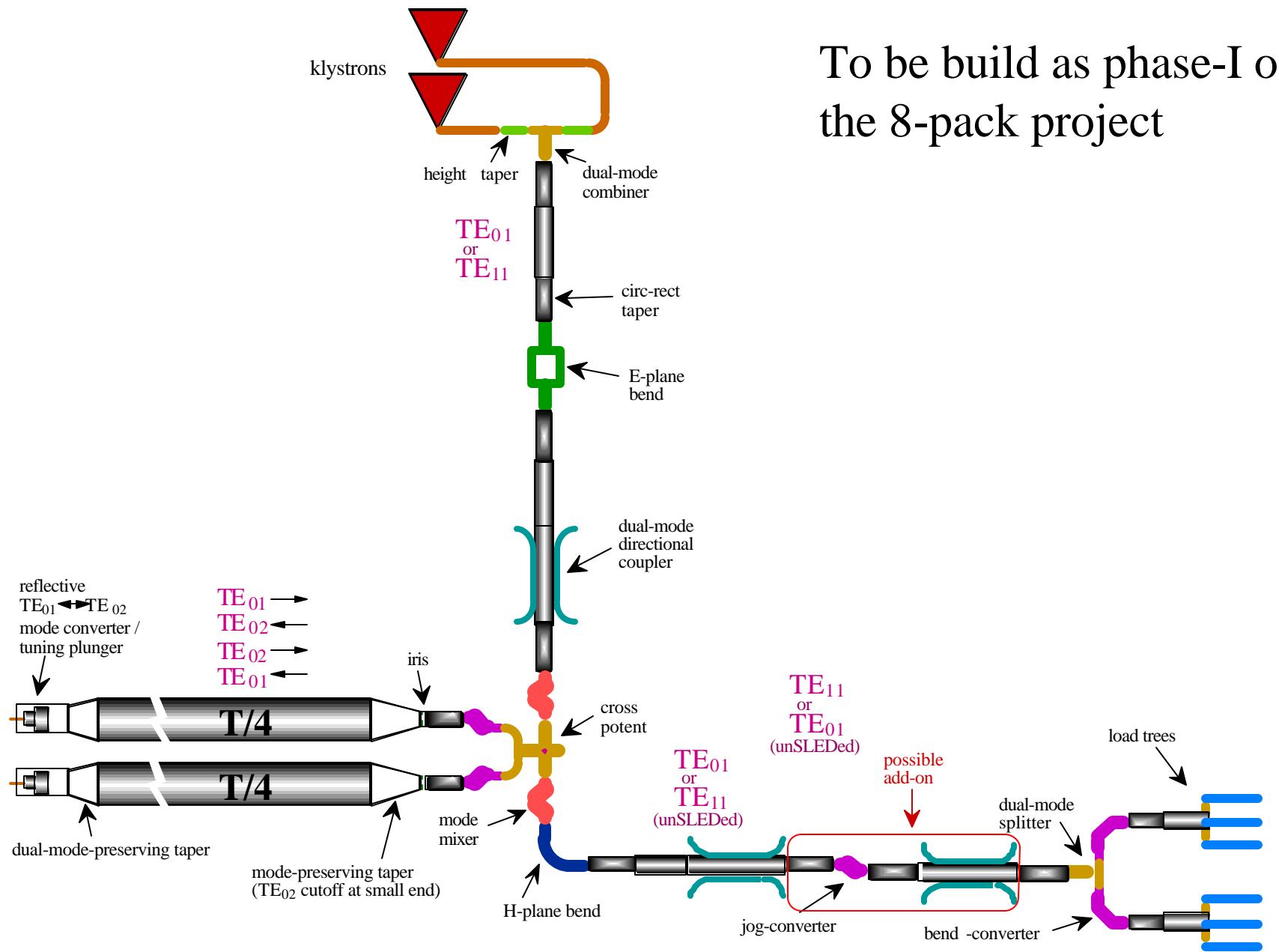
SLED-II and DLD Σ Pulse Compression

Sami G. Tantawi
SLAC

Outline

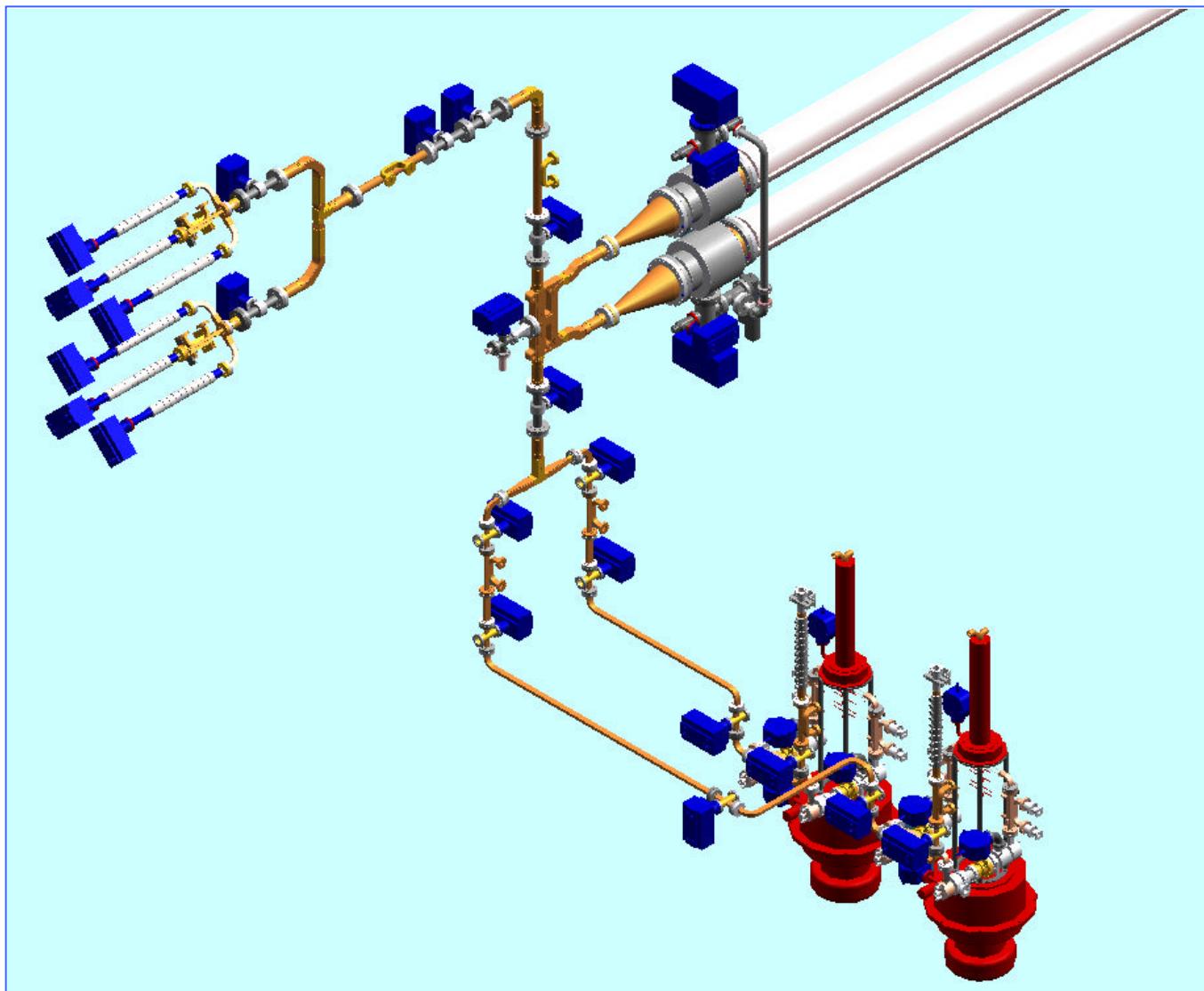
- Phase-I layout
- RF design of the SLED-II head
- RF design of the dual-moded delay lines
- Progress in active pulse compression systems

Dual-Moded Pulse Compression System

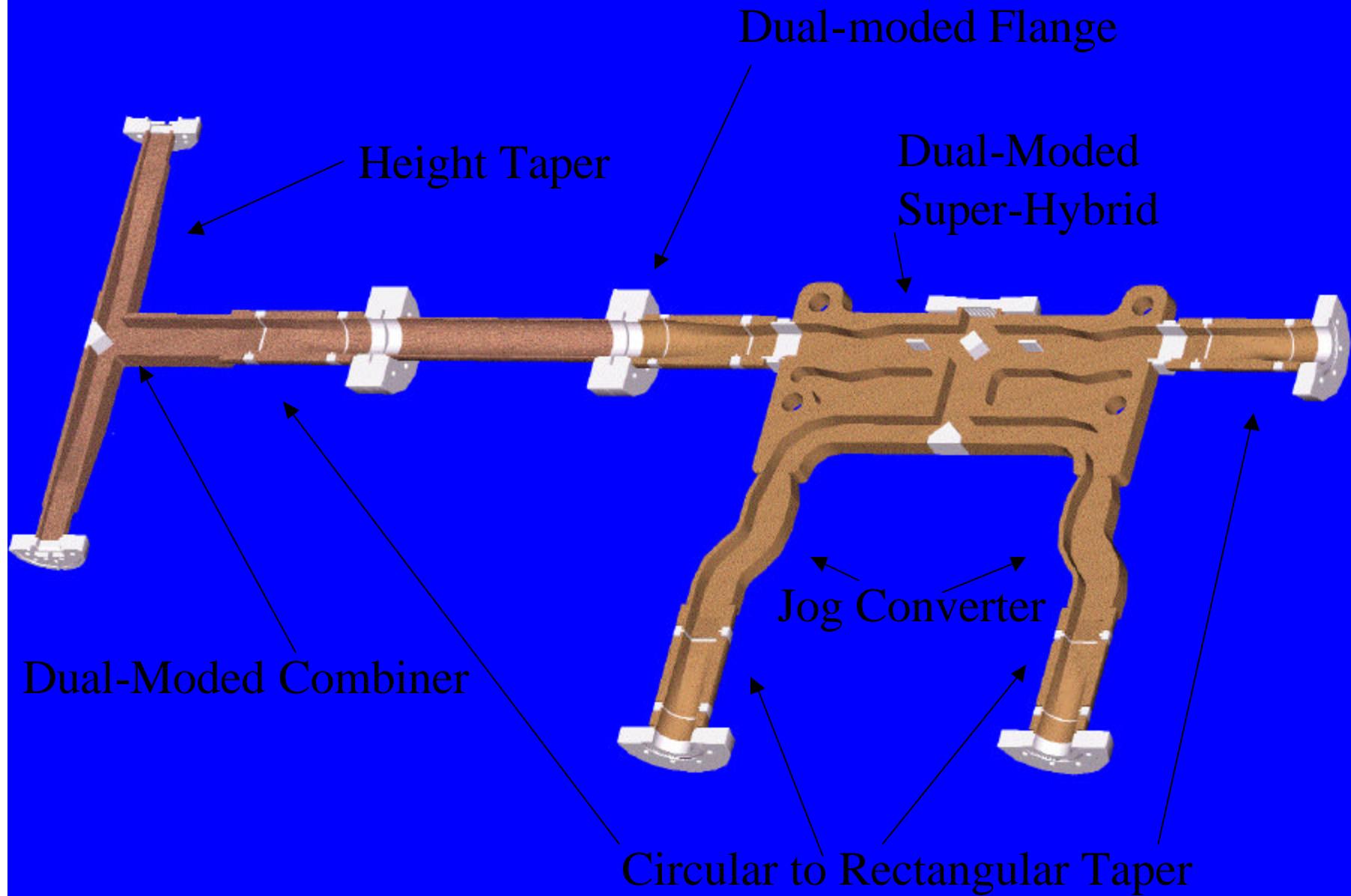


To be build as phase-I of
the 8-pack project

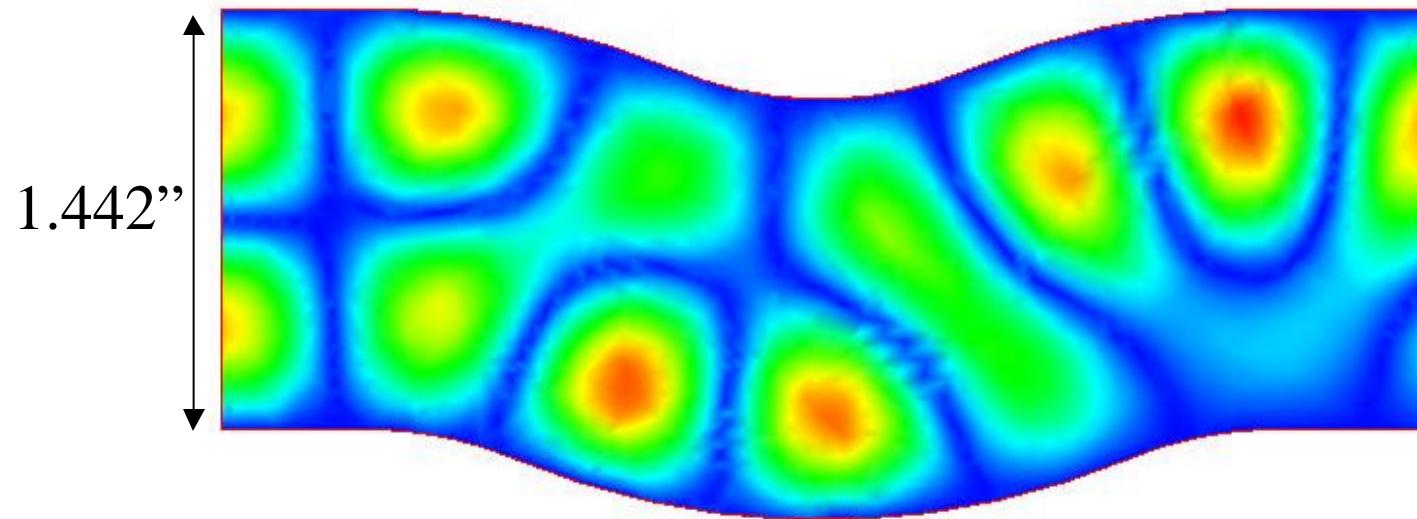
October layout for SLED commissioning



The Dual-Moded SLED-II Head

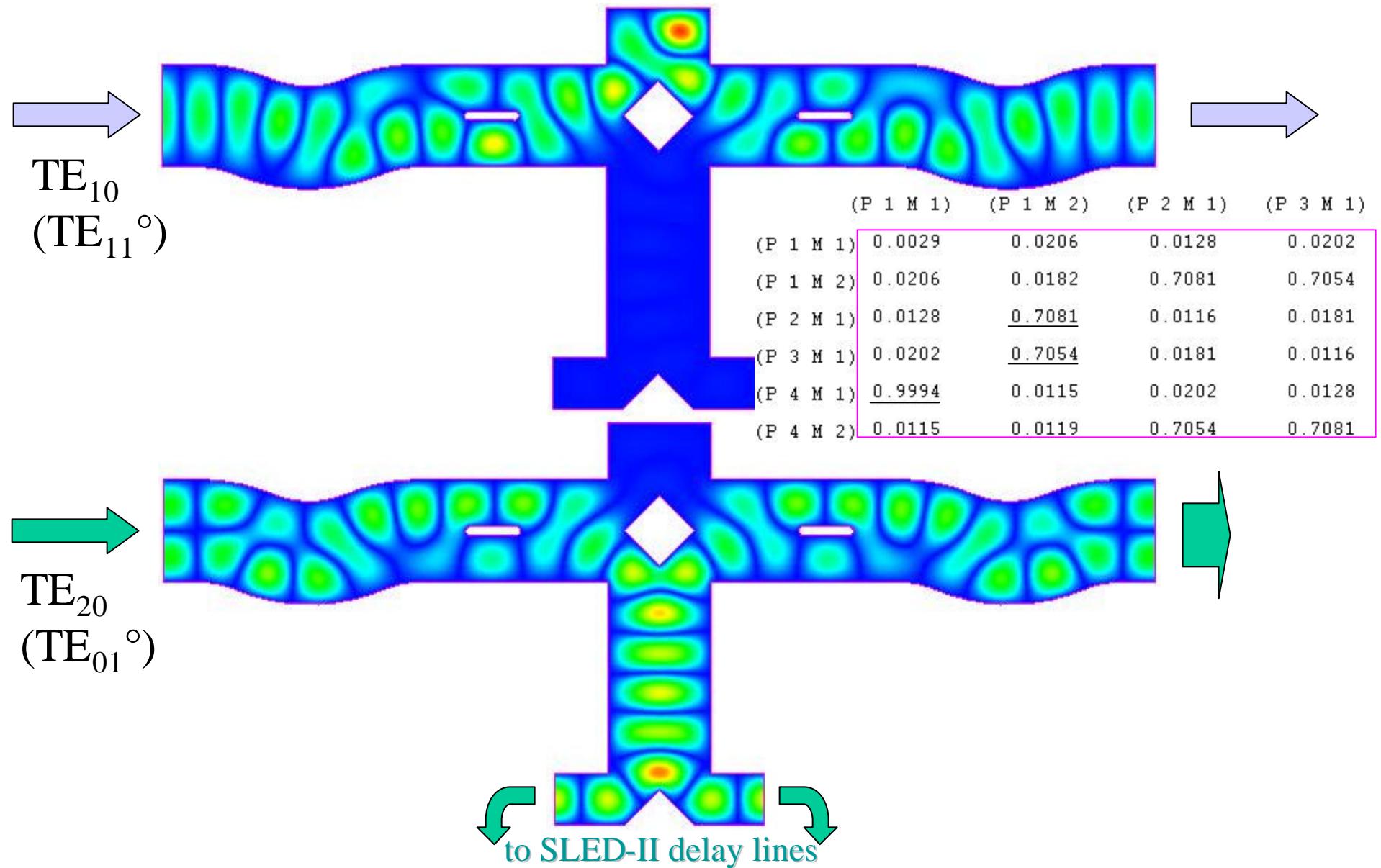


Mode Mixer

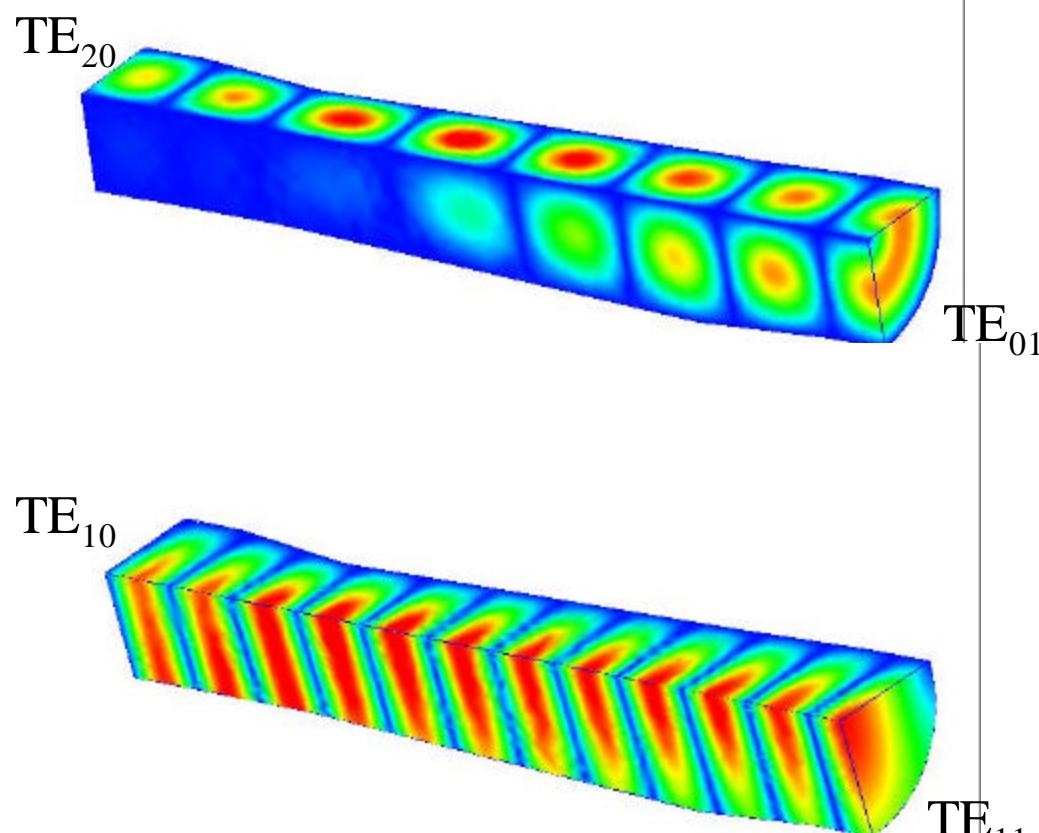


	(P 1 M 1)	(P 1 M 2)	(P 2 M 1)	(P 2 M 2)
(P 1 M 1)	0.0129	0.0118	0.7036	0.7103
(P 1 M 2)	0.0118	0.0114	0.7103	0.7037
(P 2 M 1)	0.7036	0.7103	0.0129	0.0118
(P 2 M 2)	0.7103	0.7037	0.0118	0.0114

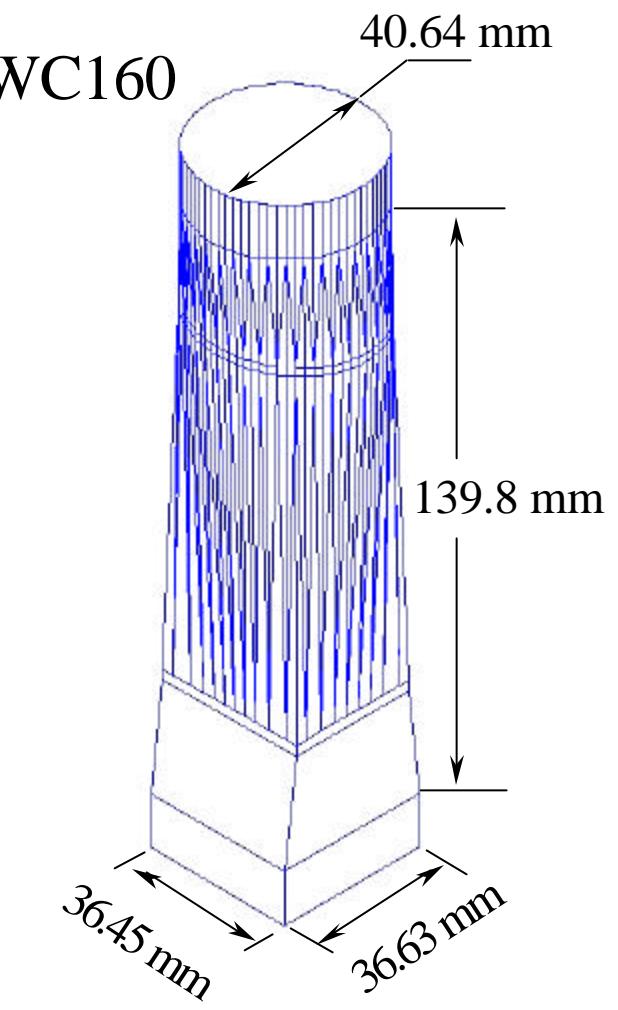
8-Pack Phase-I Super Hybrid



Dual-Mode Rectangular-to-Circular Taper

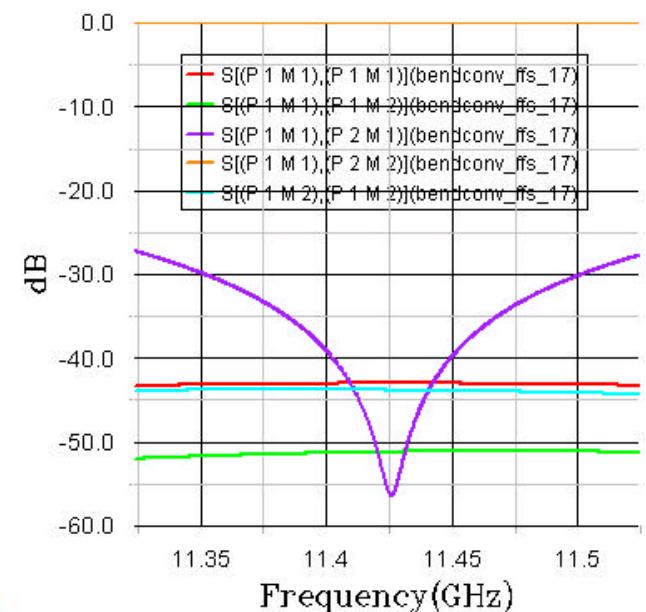
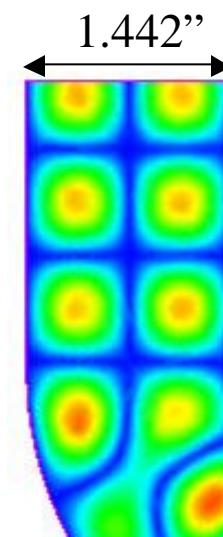
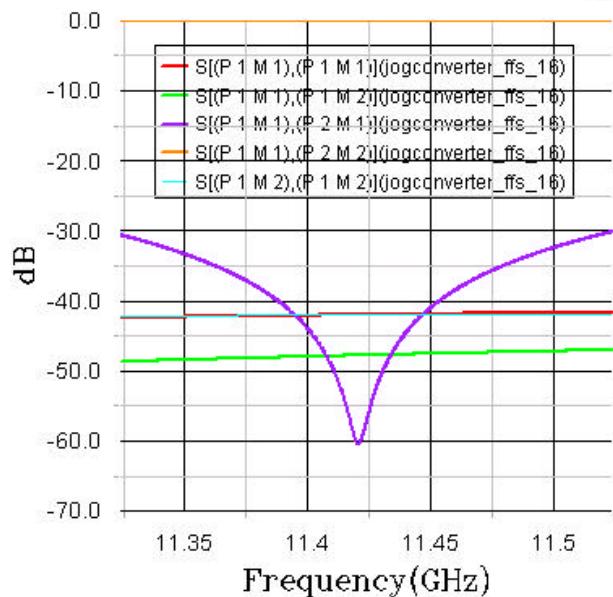
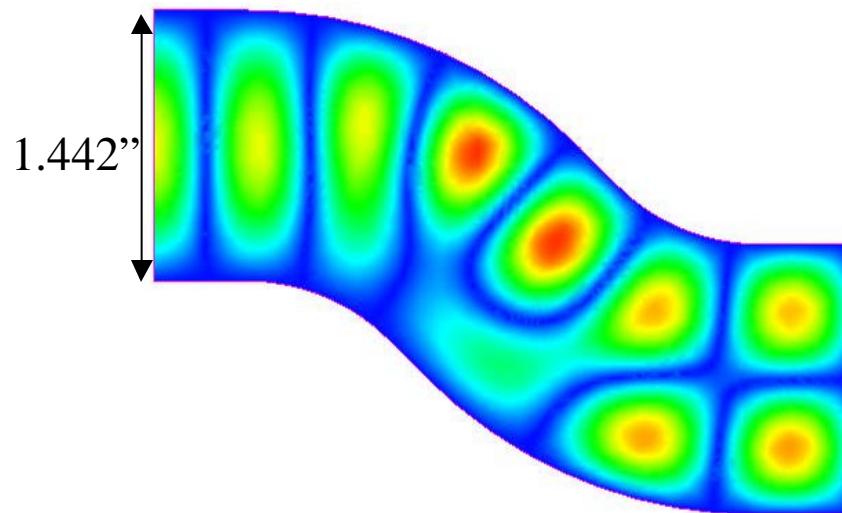


Simulated electric fields (HFSS) of the multi-moded circular to rectangular taper

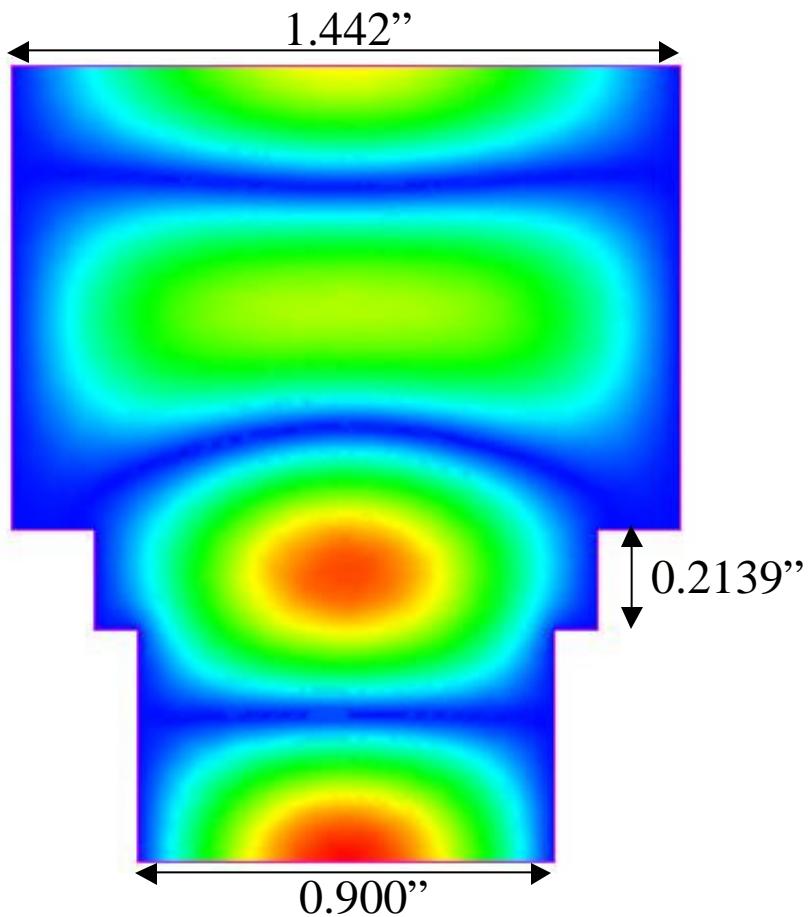


Taper Geometry

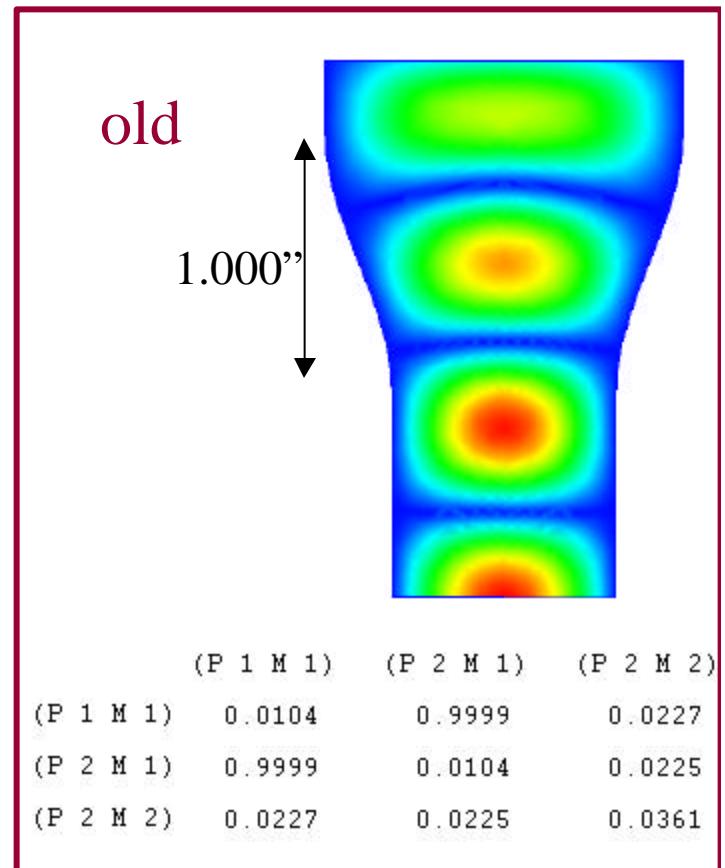
Jog Converter and Bend Converter



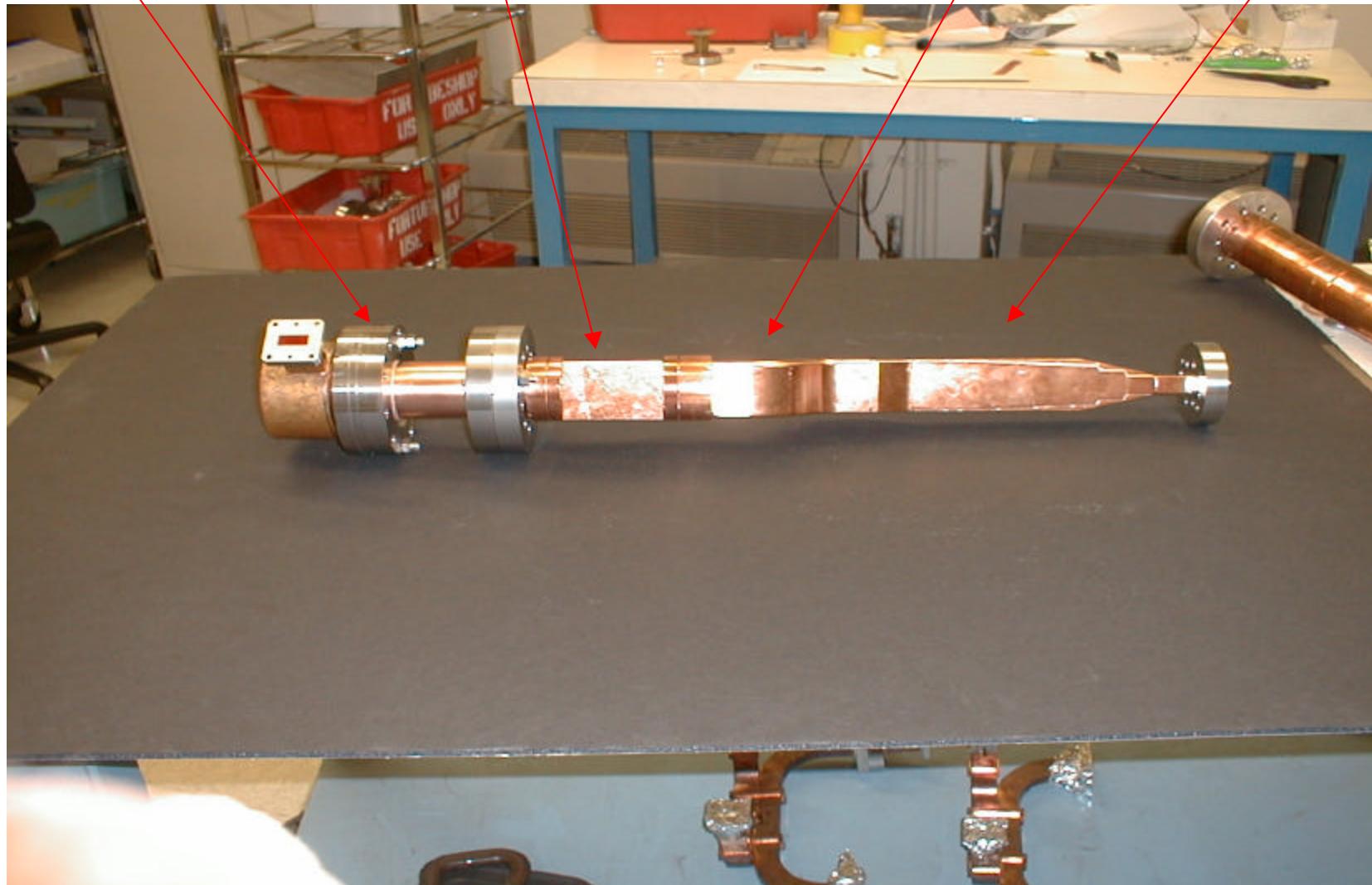
Width Taper ($0.900'' \rightarrow 1.442''$)



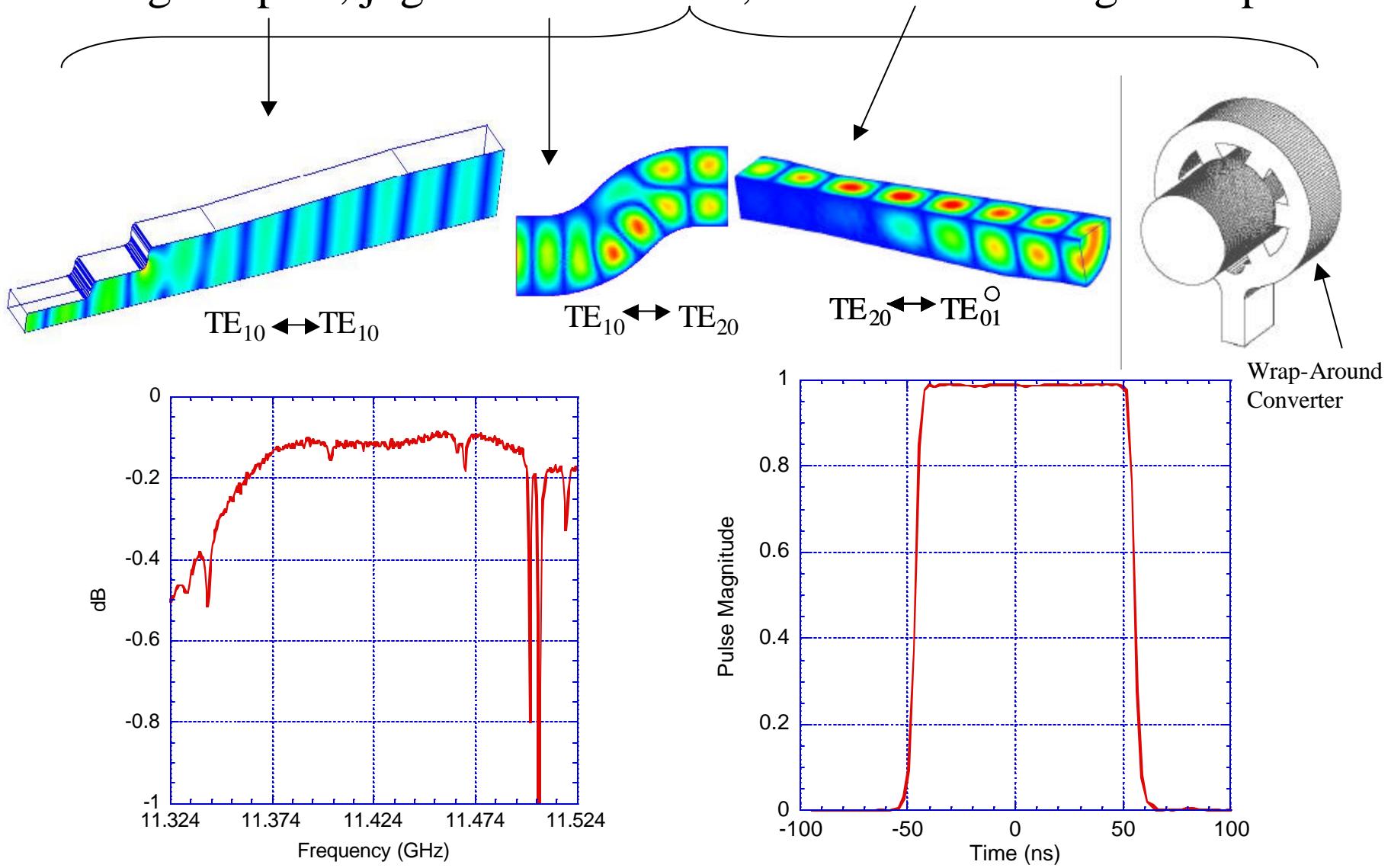
	(P 1 M 1)	(P 2 M 1)	(P 2 M 2)
(P 1 M 1)	0.0001	1	8.586e-006
(P 2 M 1)	1	0.0001	8.587e-006
(P 2 M 2)	8.586e-006	8.587e-006	1



Wraparound mode converter, circular to rectangular taper, jog mode converter, height tapers,

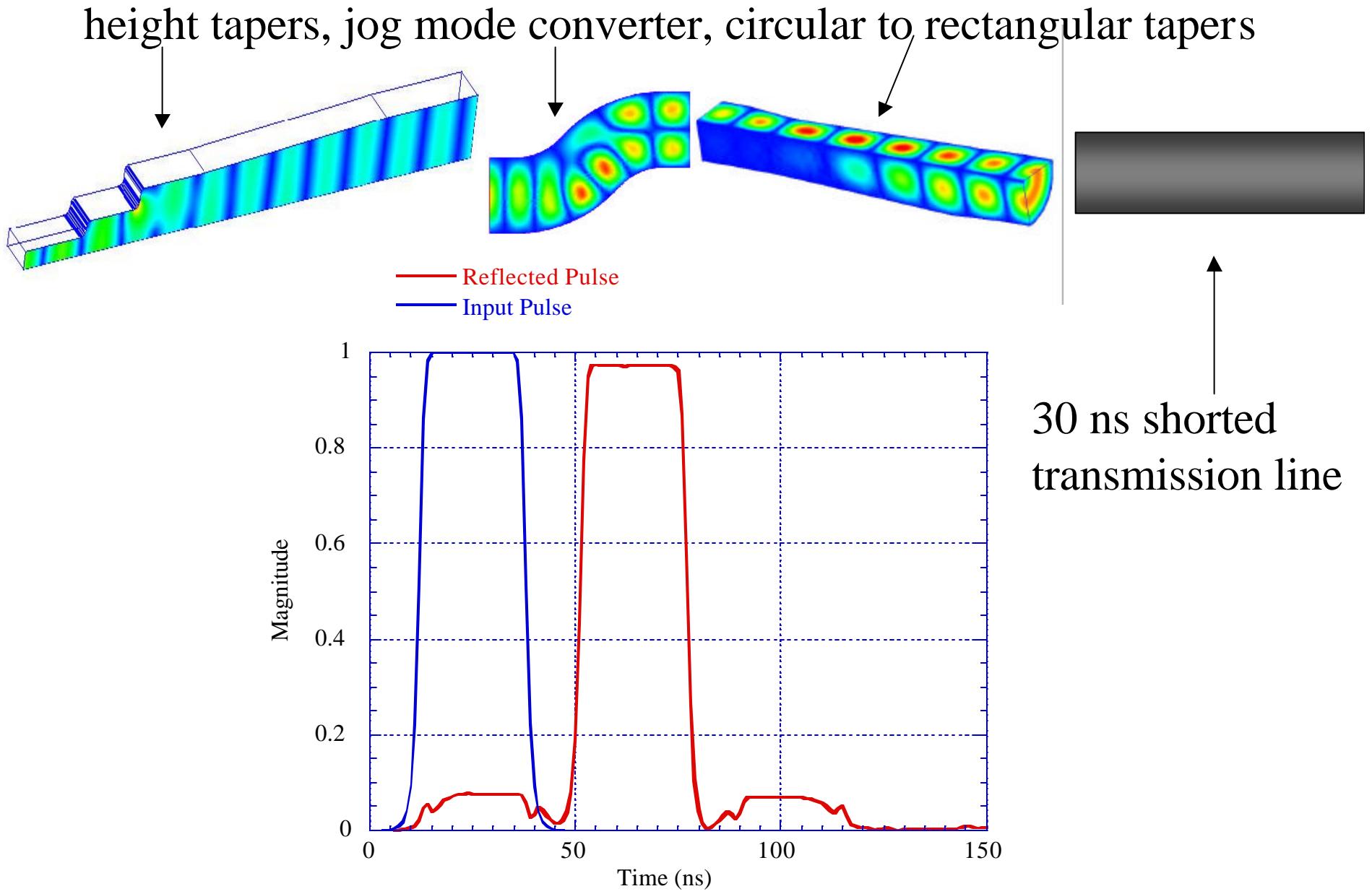


An Assembly to test new components and concepts:
height tapers, jog mode converter, circular to rectangular tapers



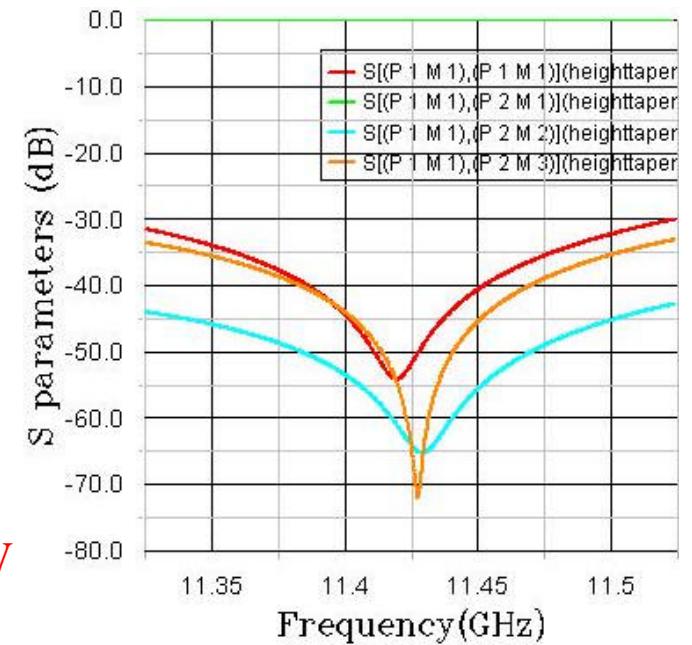
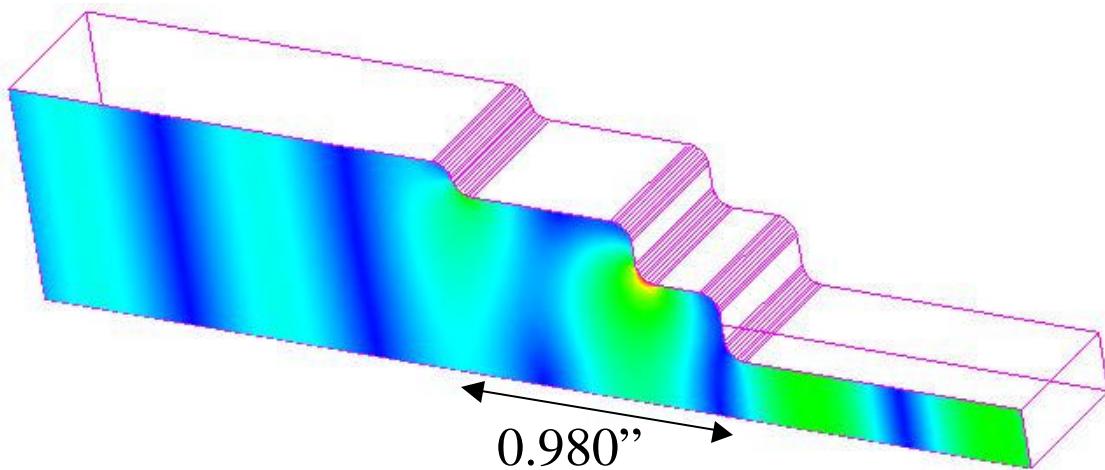
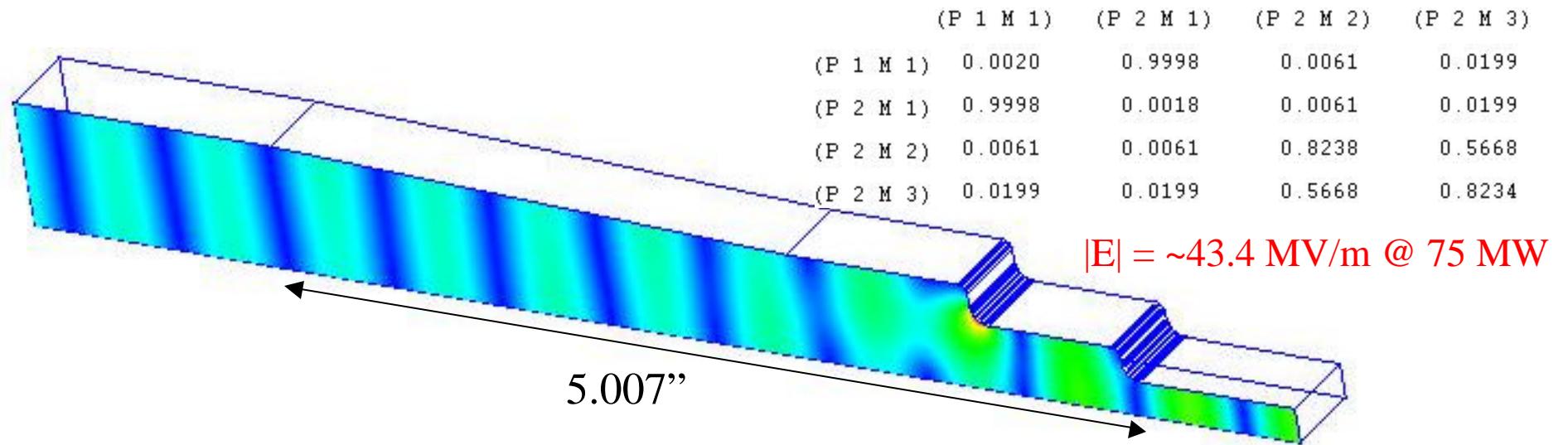
Frequency response of the assembly (S_{12})

Transmitted pulse through the assembly

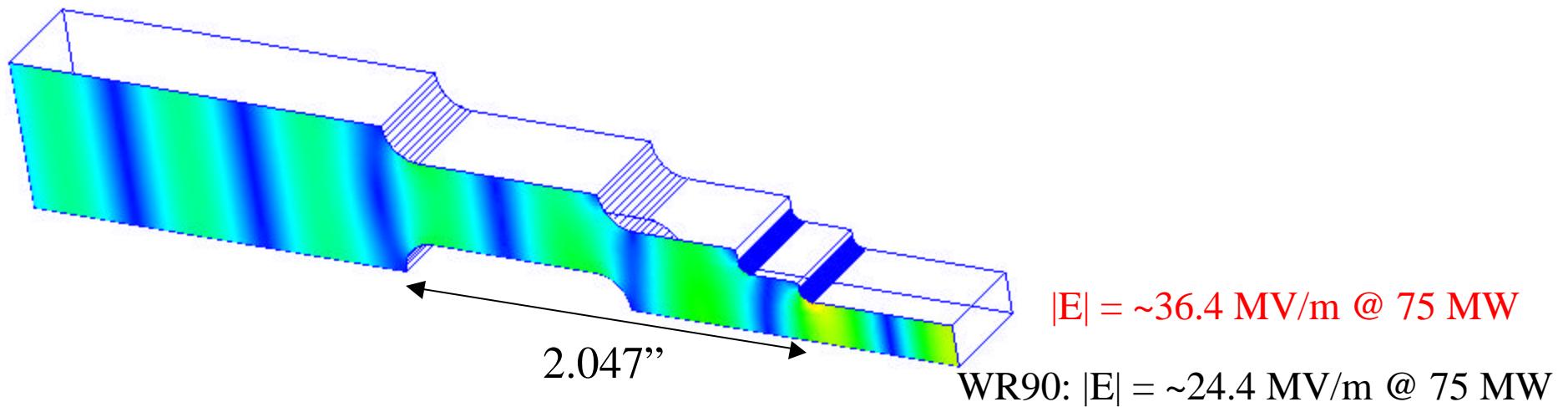


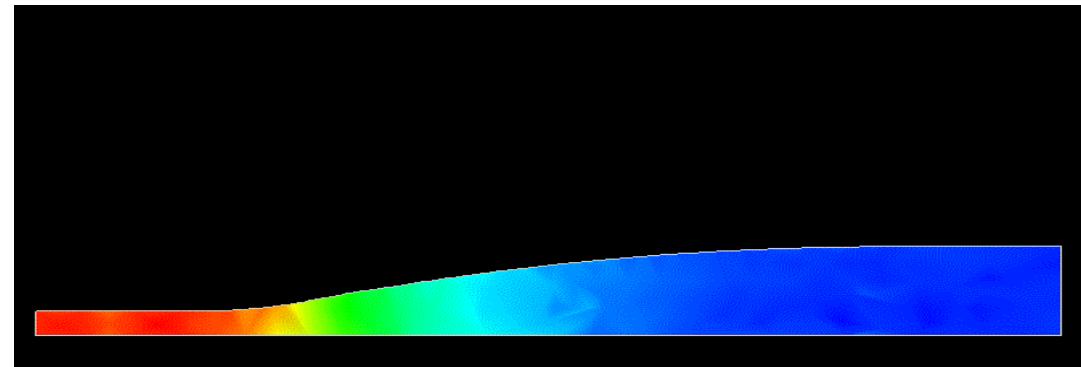
Reflection after an approximately 30 ns Transmission line

Height Taper ($0.400'' \rightarrow 1.435''$)

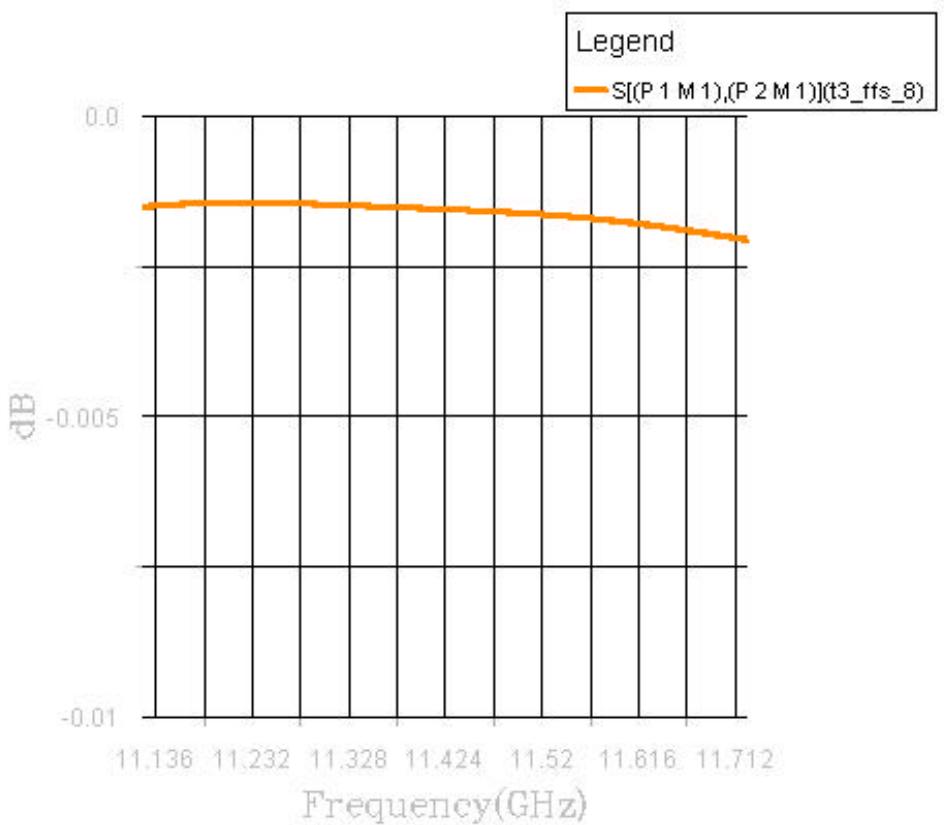


Height Taper

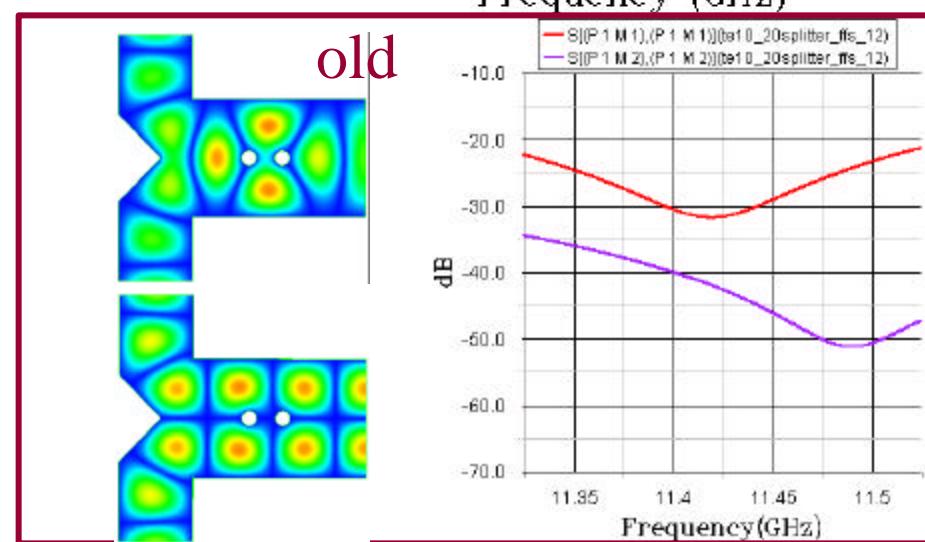
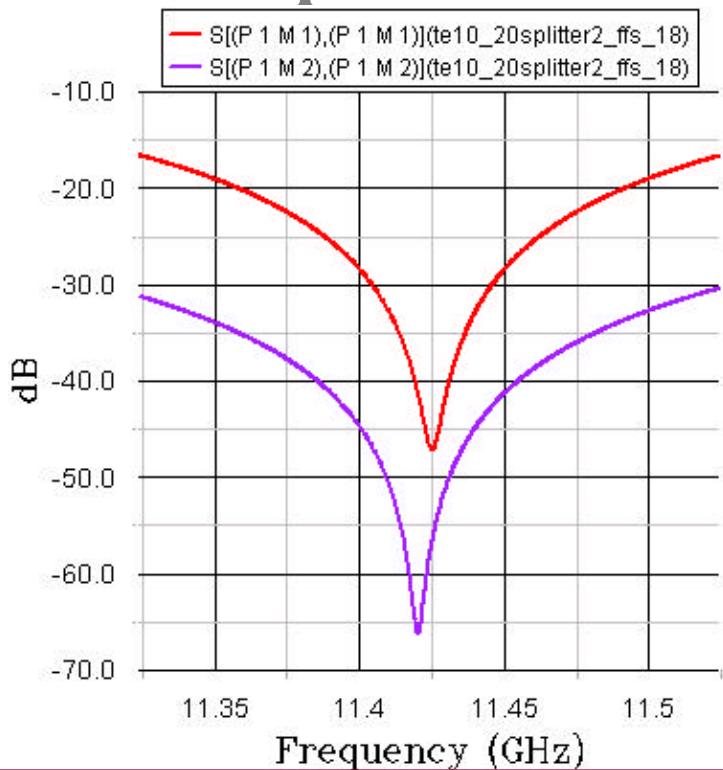
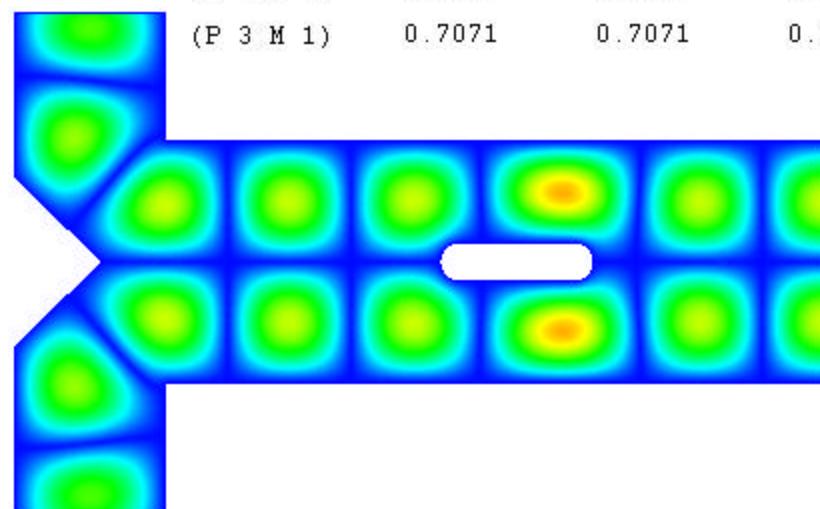
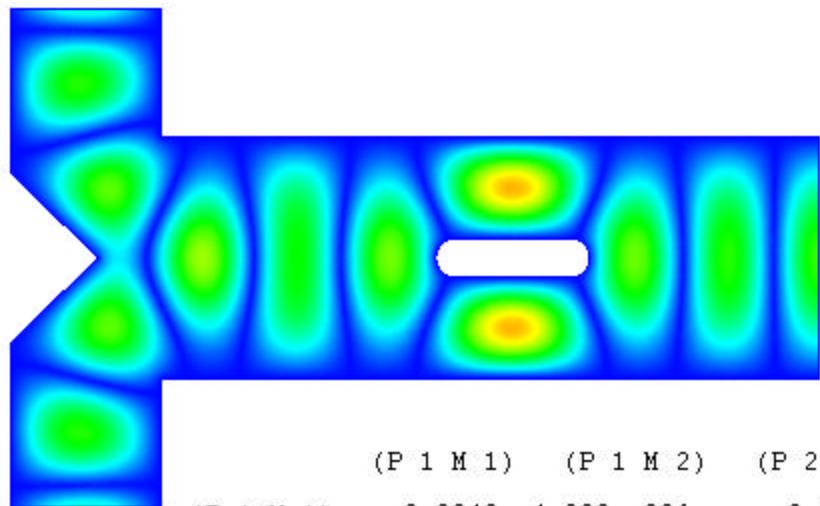




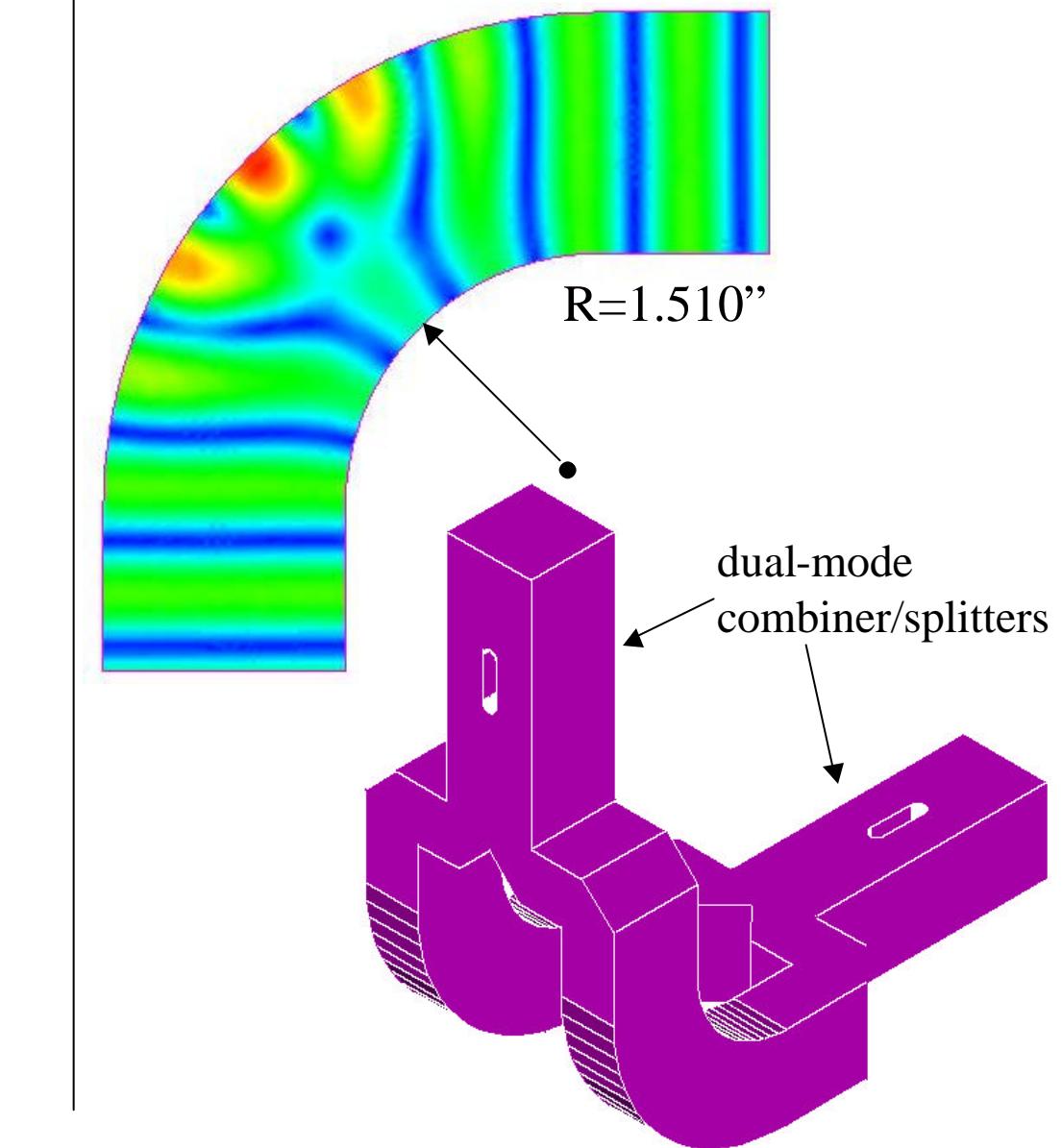
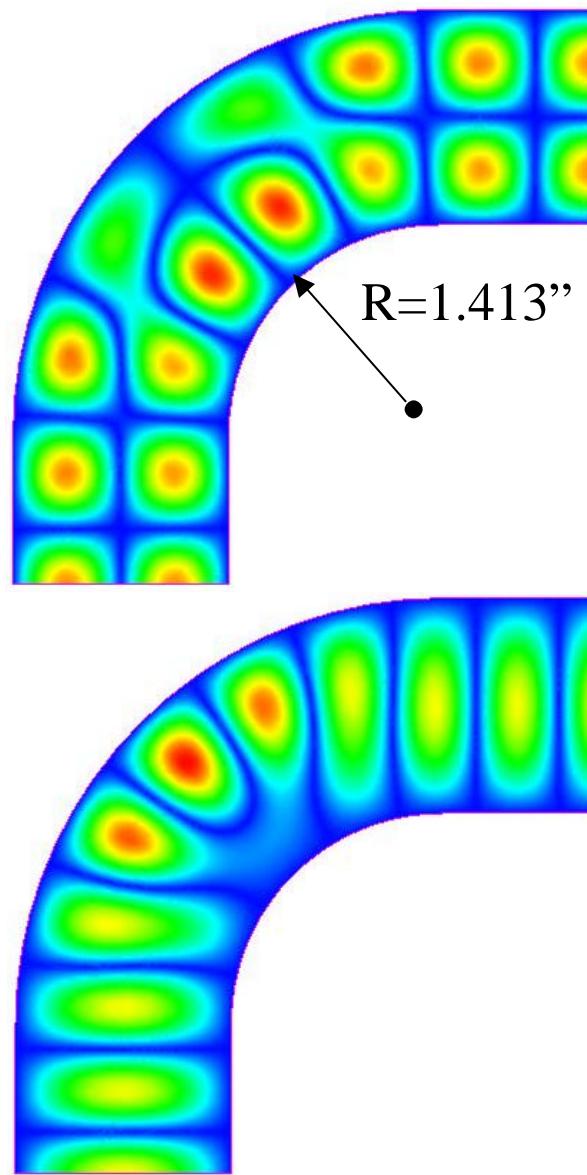
Height Taper
Peak Field~ 25 MV/m @ 75 MW
Total Length ~ 4 inches



Dual-Mode Combiner/Splitter

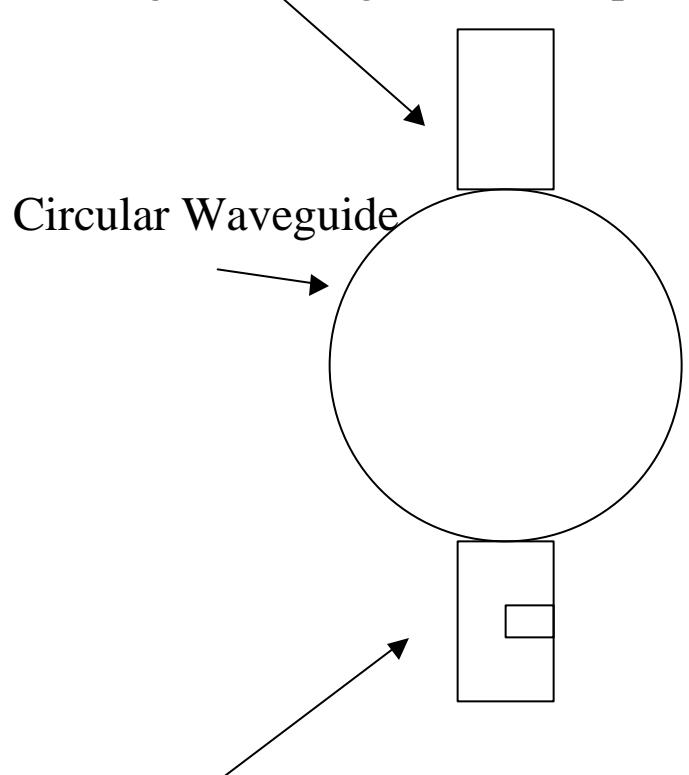


H-Plane Bend and E-Plane Bend



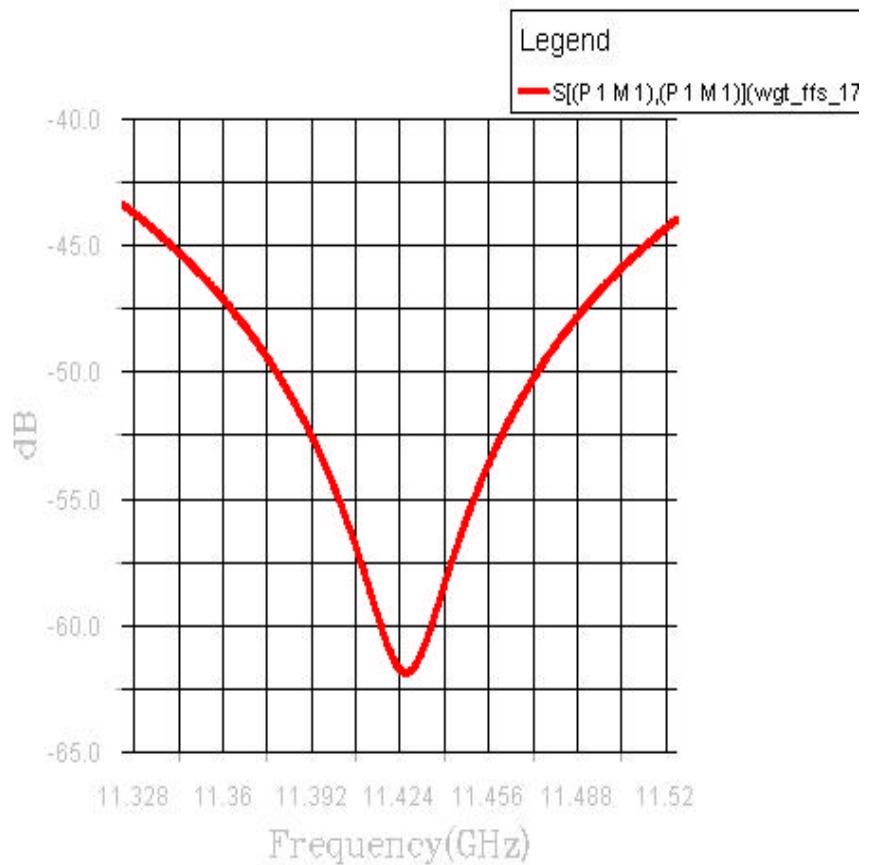
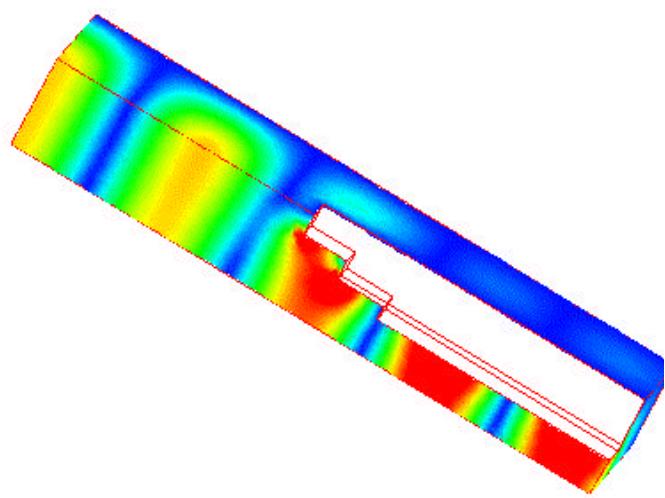
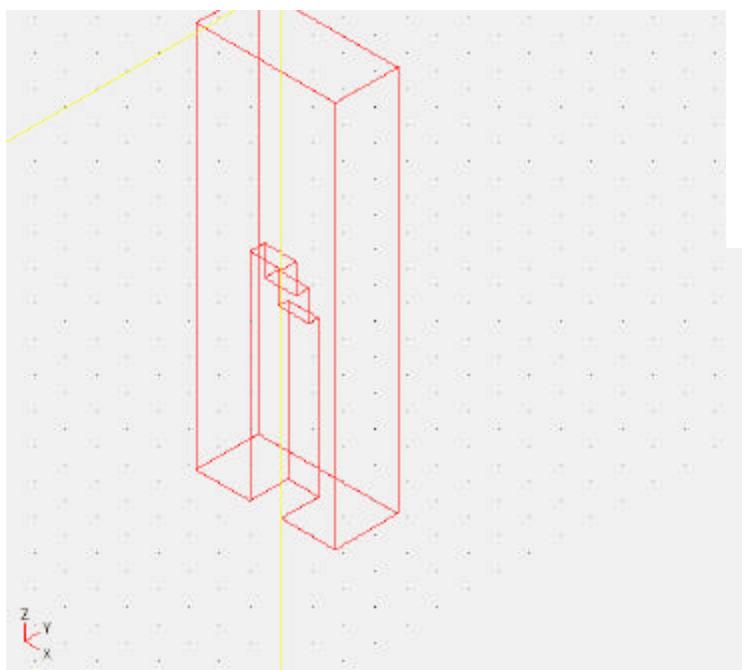
Dual-Moded Directional Coupler

Rectangular waveguide for coupling the TE_{01} mode

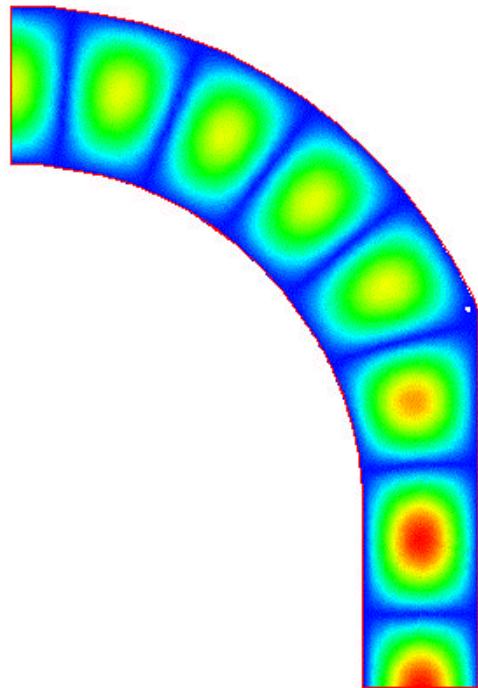


The waveguide sizes are chosen to match wavelengths between the circular waveguide modes and side waveguide fundamental mode

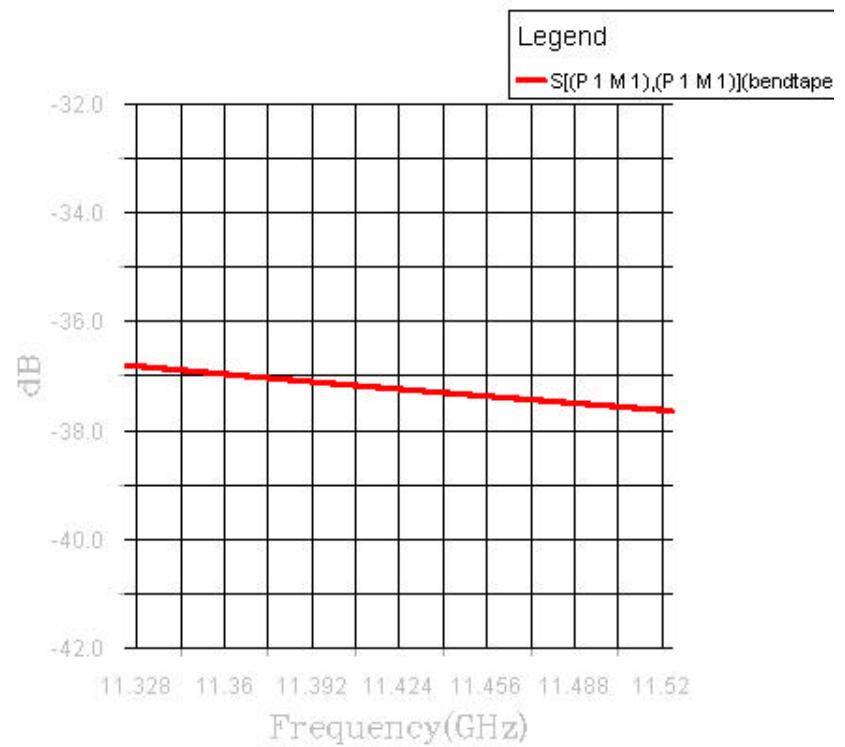
The coupling hole pattern represents a Hamming window



End taper for TE_{11} coupler



End taper for the TE_{01} coupler



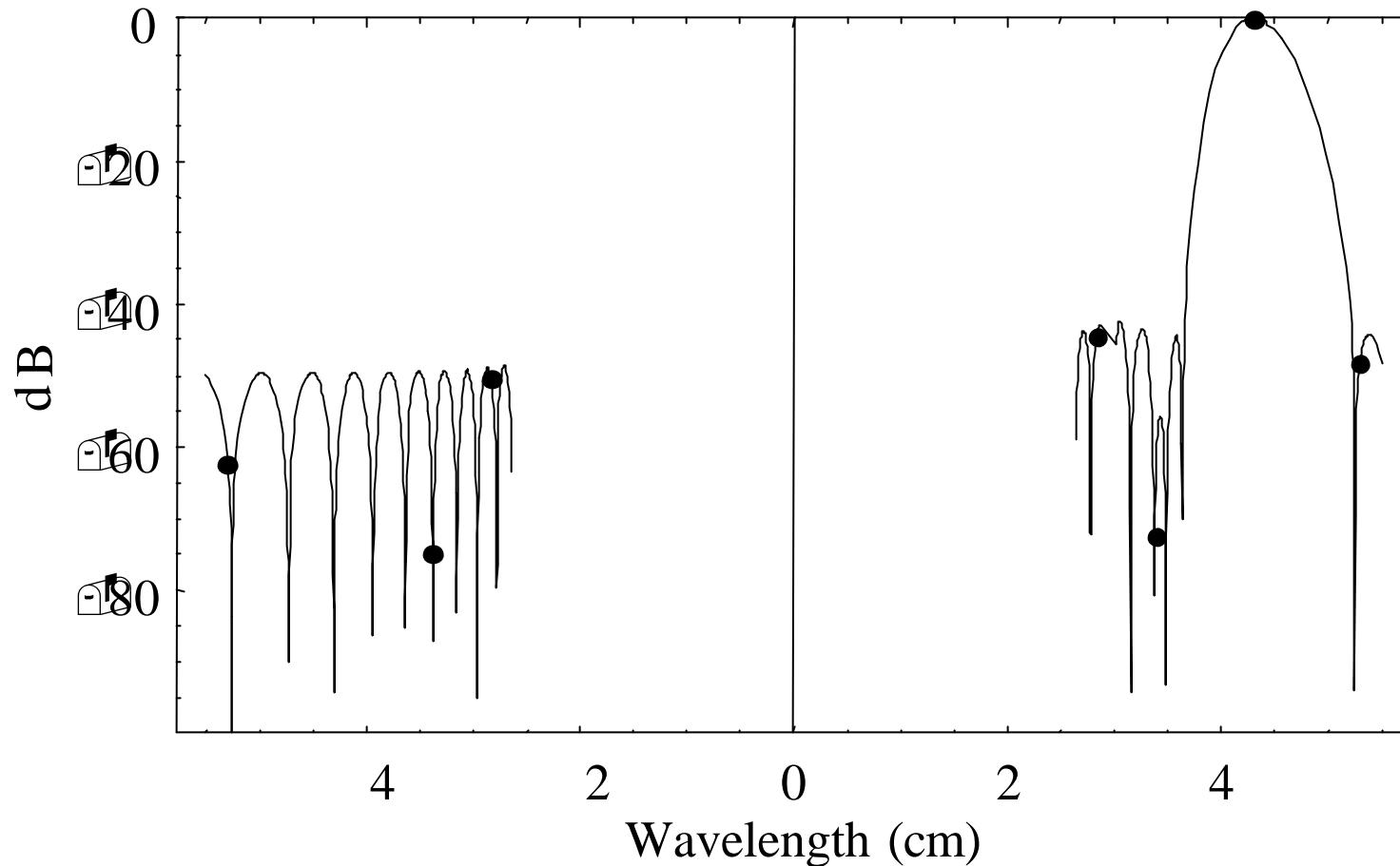
TE_{01} directional coupler response (relative)

Coupler Length = 50.6 cm

Number of coupling holes=44

Backward coupling

Forward Coupling

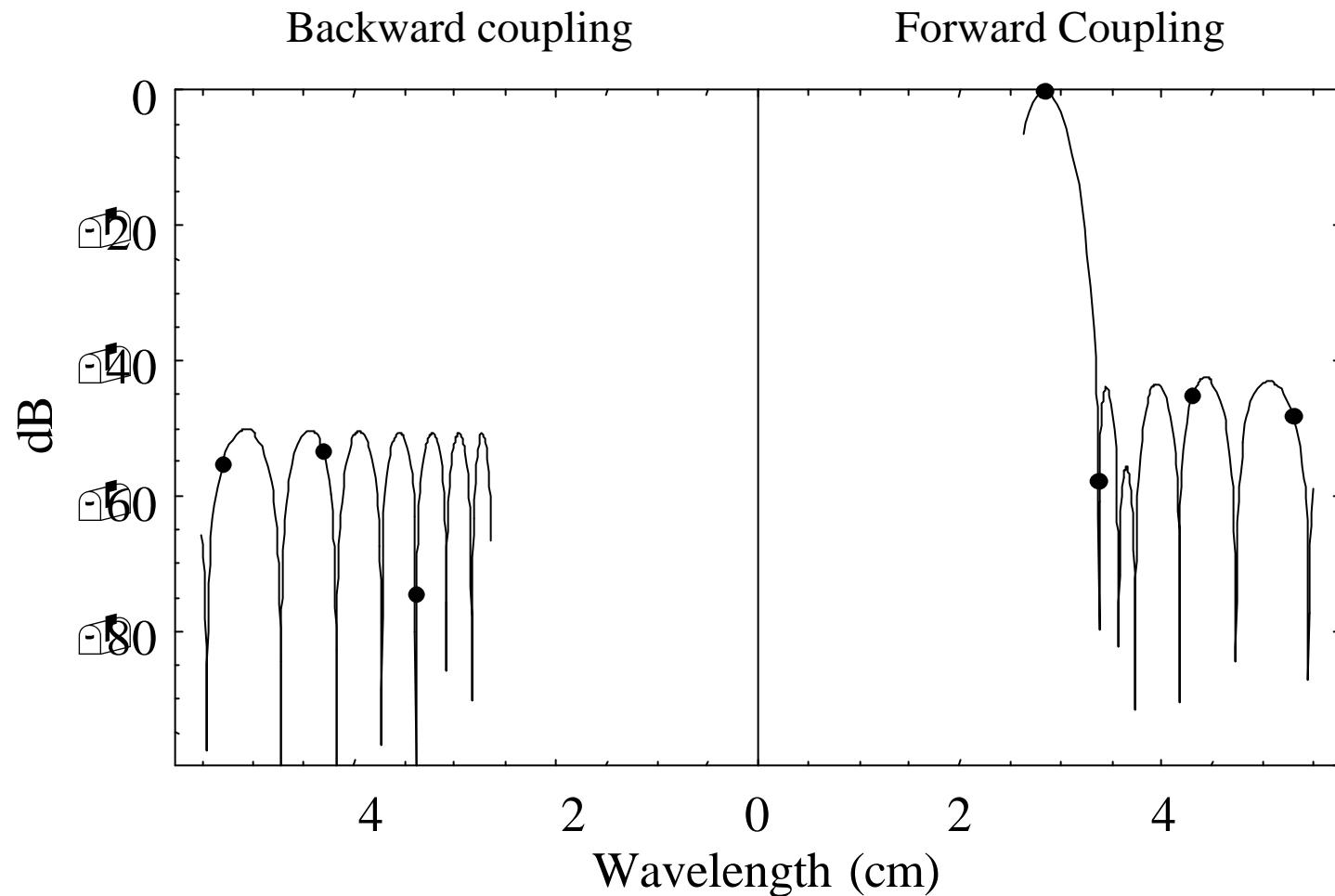


Points represent the following modes: TE_{11} , TE_{21} , TE_{01} , TE_{31}

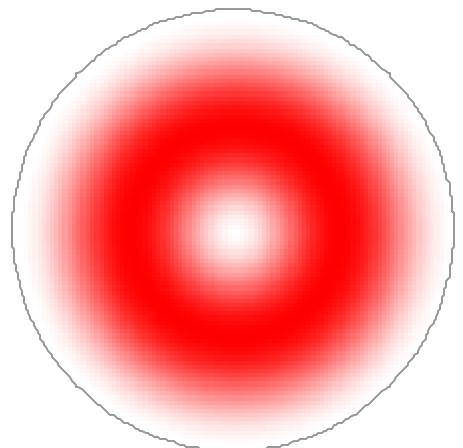
TE_{11} directional coupler response (relative)

Coupler Length =38.3 cm

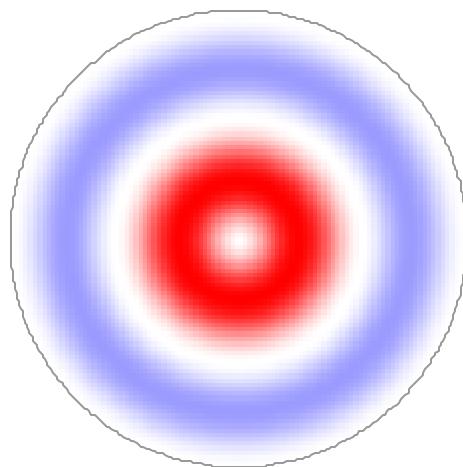
Number of coupling holes=51



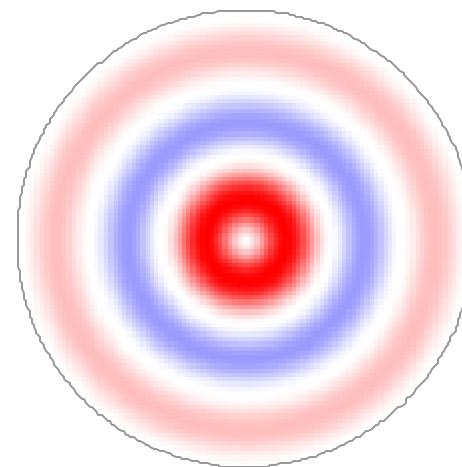
Points represent the following modes: TE_{11} , TE_{21} , TE_{01} , TE_{31}



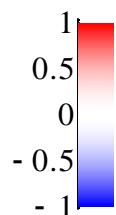
TE₀₁

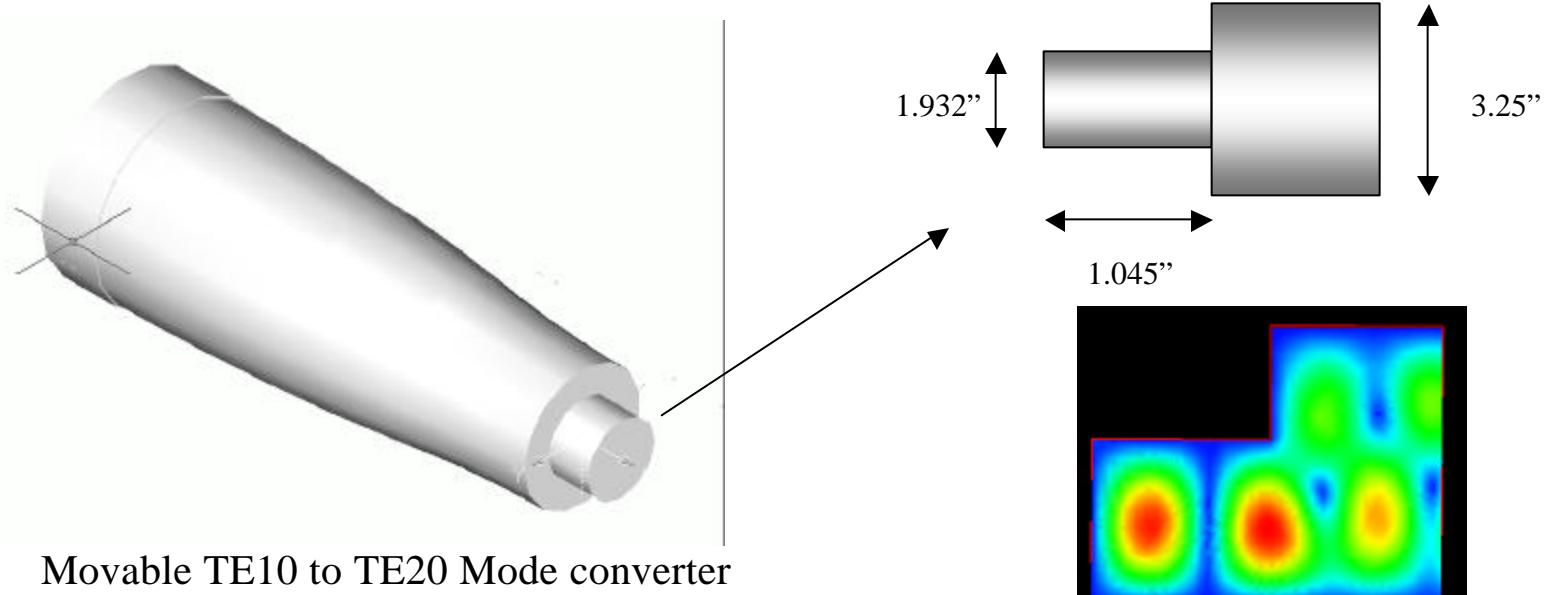


TE₀₂

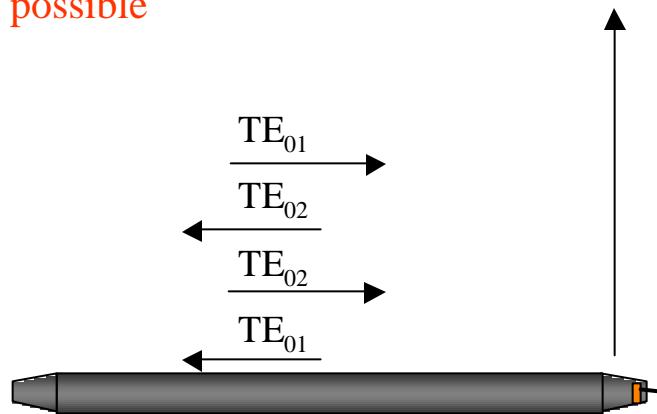


TE₀₃



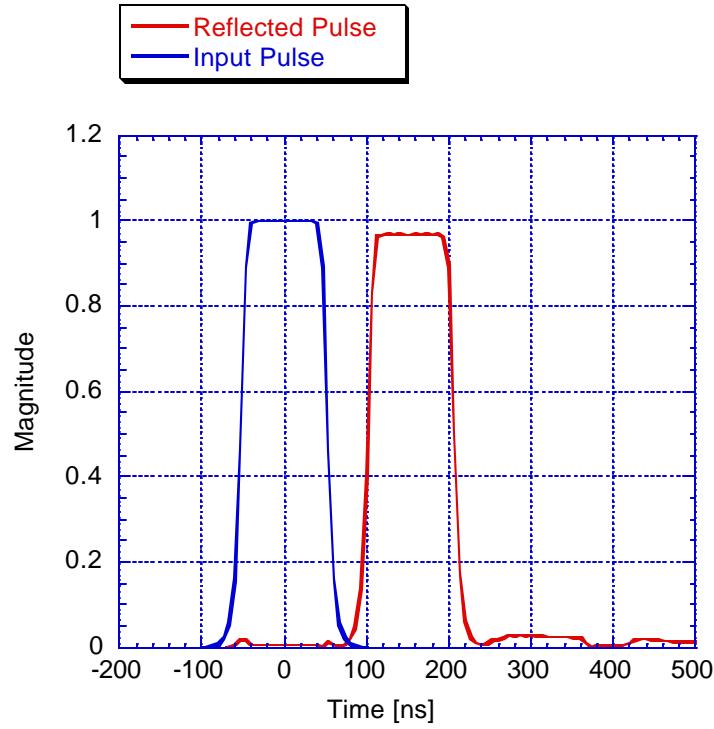


More sophisticated Mode converters for 4-mode and even 10 mode Delay lines are also possible

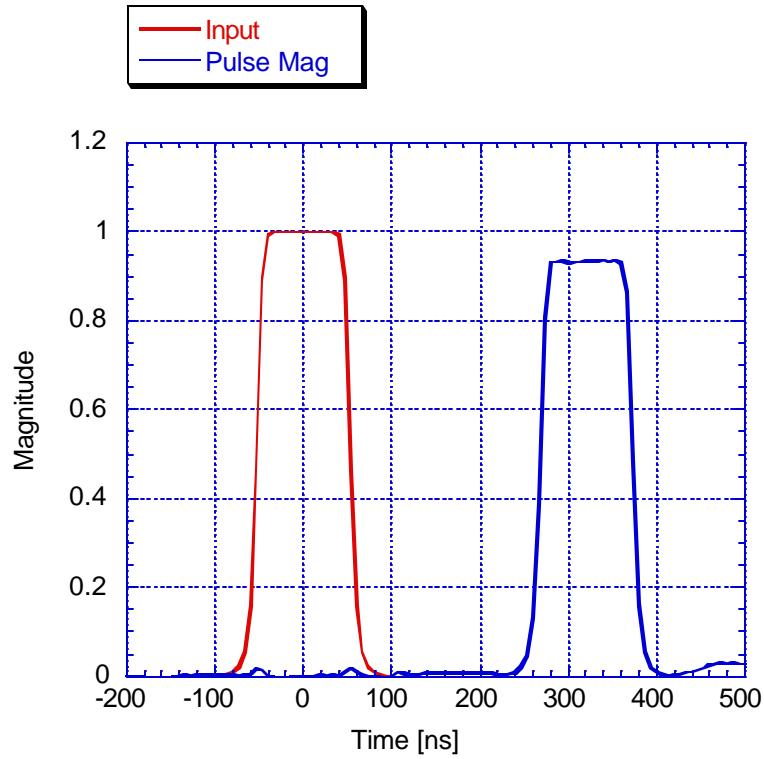


	TE_{01} (P 1 M 1)	TE_{02} (P 1 M 2)
(P 1 M 1)	0.0147	0.9999
(P 1 M 2)	0.9999	0.0147

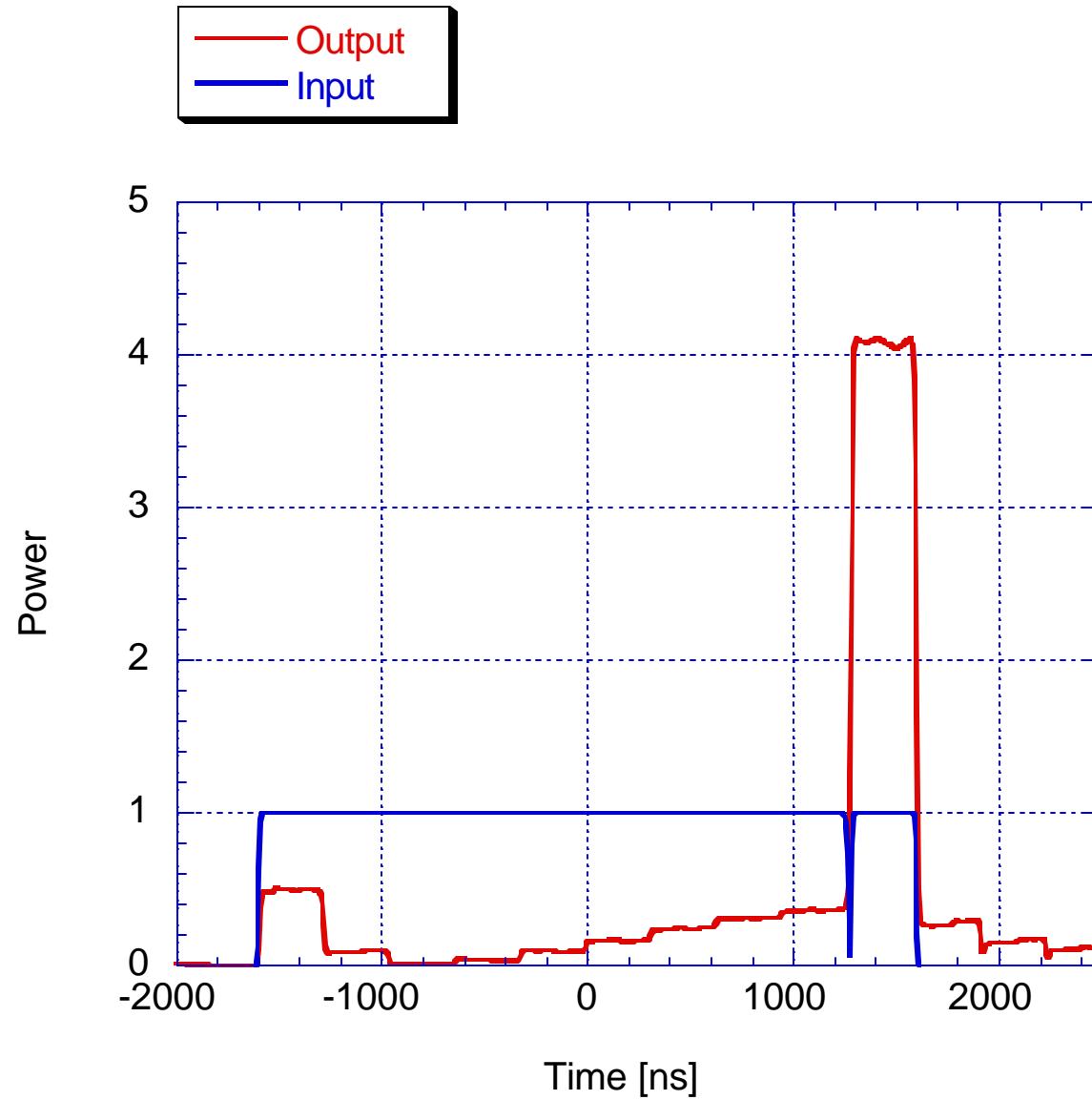
Field Pattern within the device. Peak field at 300 MW (one device per transmission line) is 26.6 MV/m. This field is in the middle of the small guide.



Measured Delay through 75 feet of WC475 waveguide terminated with a flat plate. The round trip delay time is 154 ns

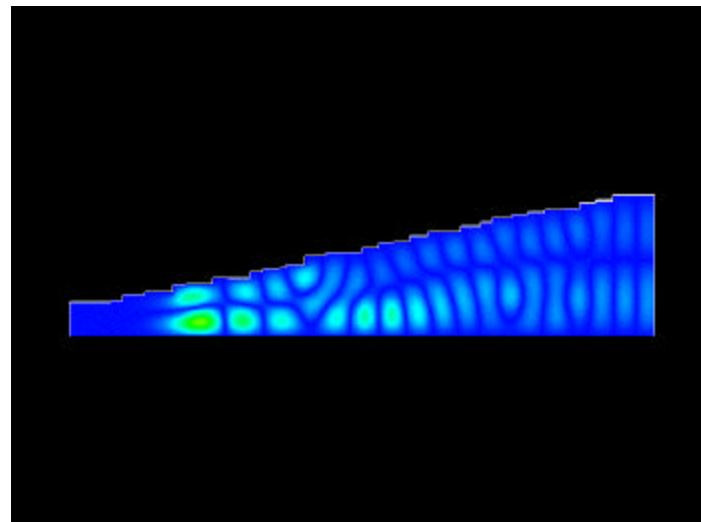
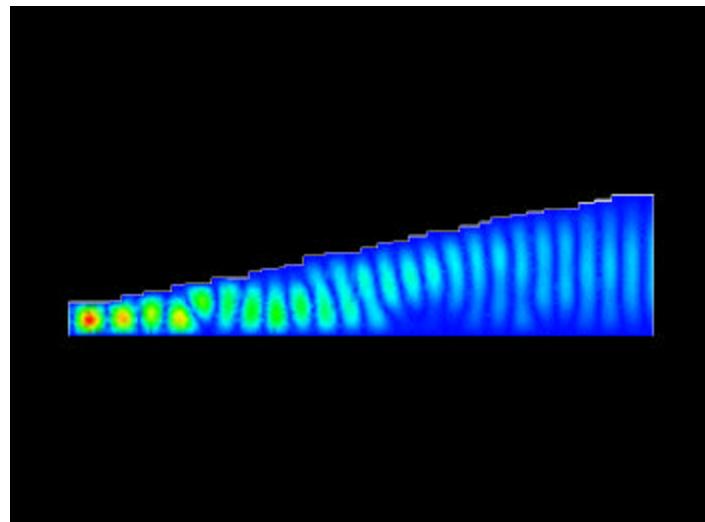
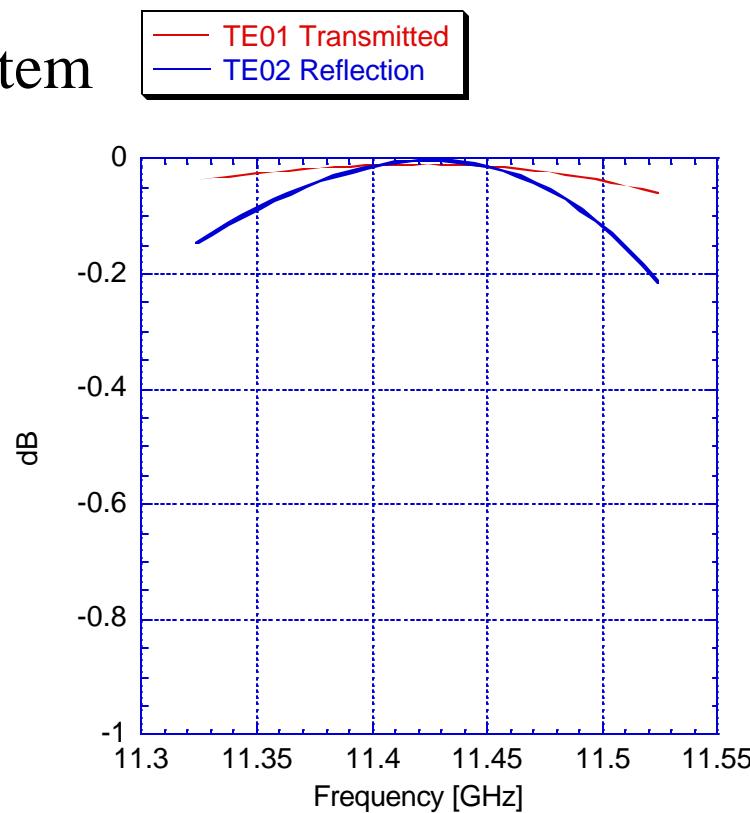
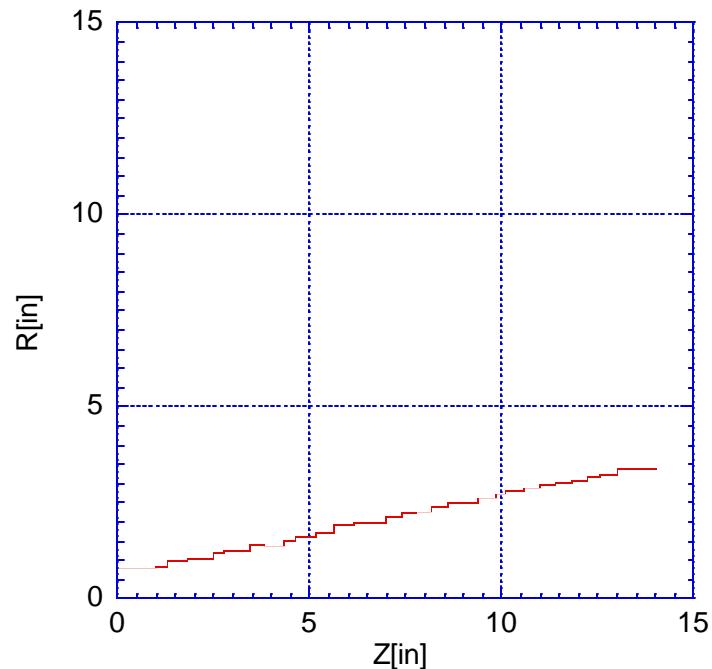


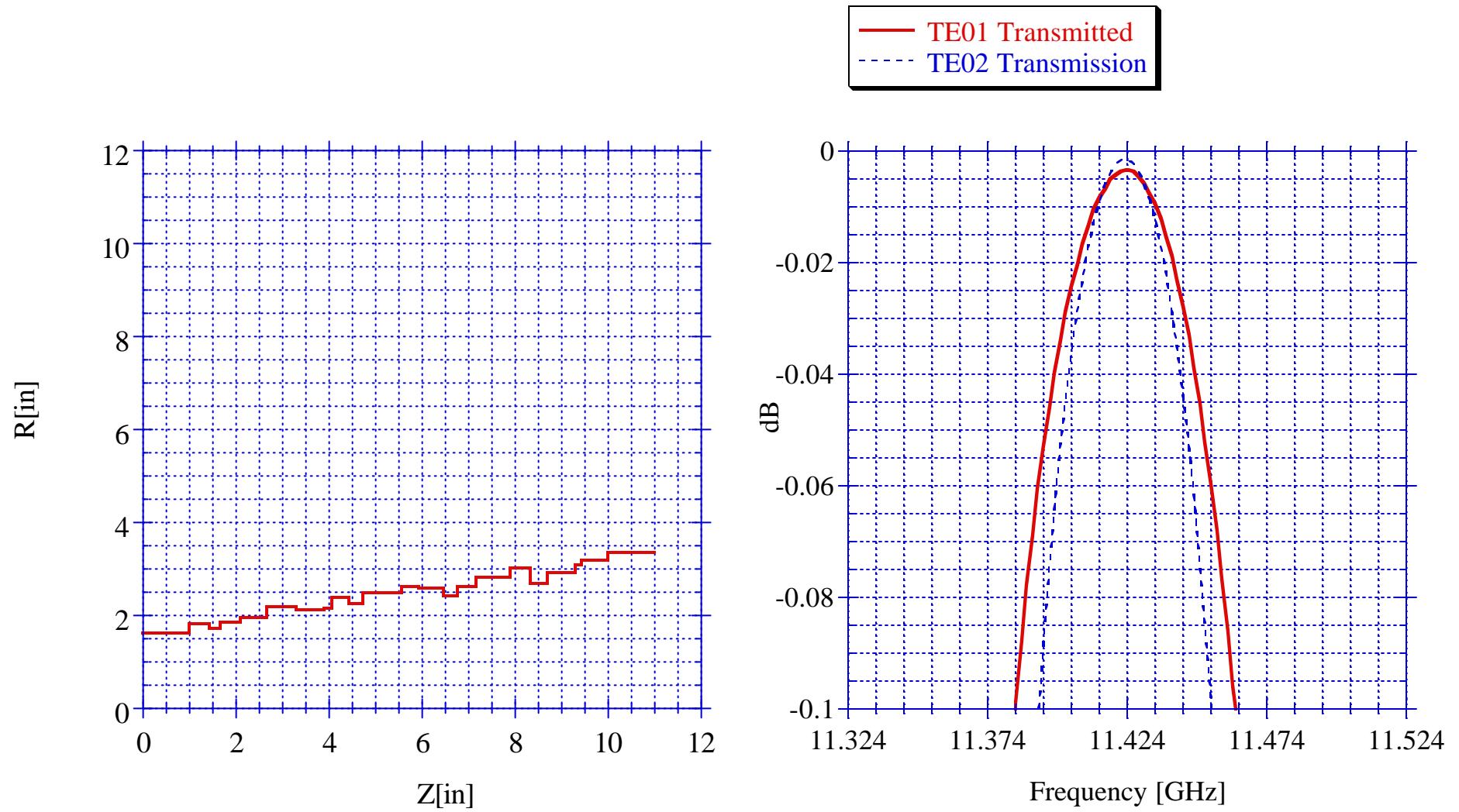
Measured delay through 75 feet of WC475 waveguide terminated with a TE01-TE02 Mode converter. The round trip delay time is 320 ns



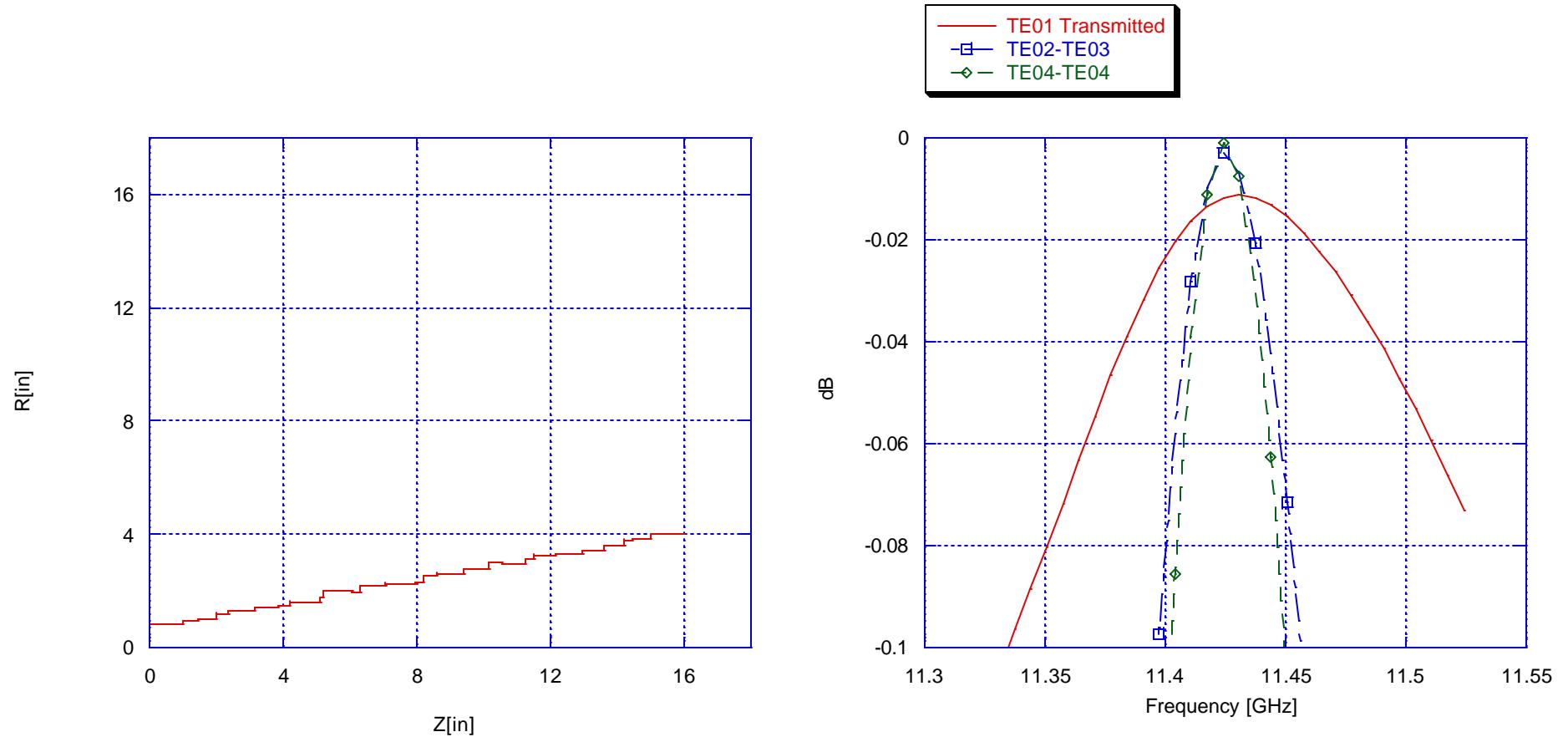
Measured Response of the dual-mode SLED-II Pulse compression system at a compression ratio of 10. Delay line length is 75 feet. Output pulse width is 320 ns.

Input Taper for a Dual-Moded System

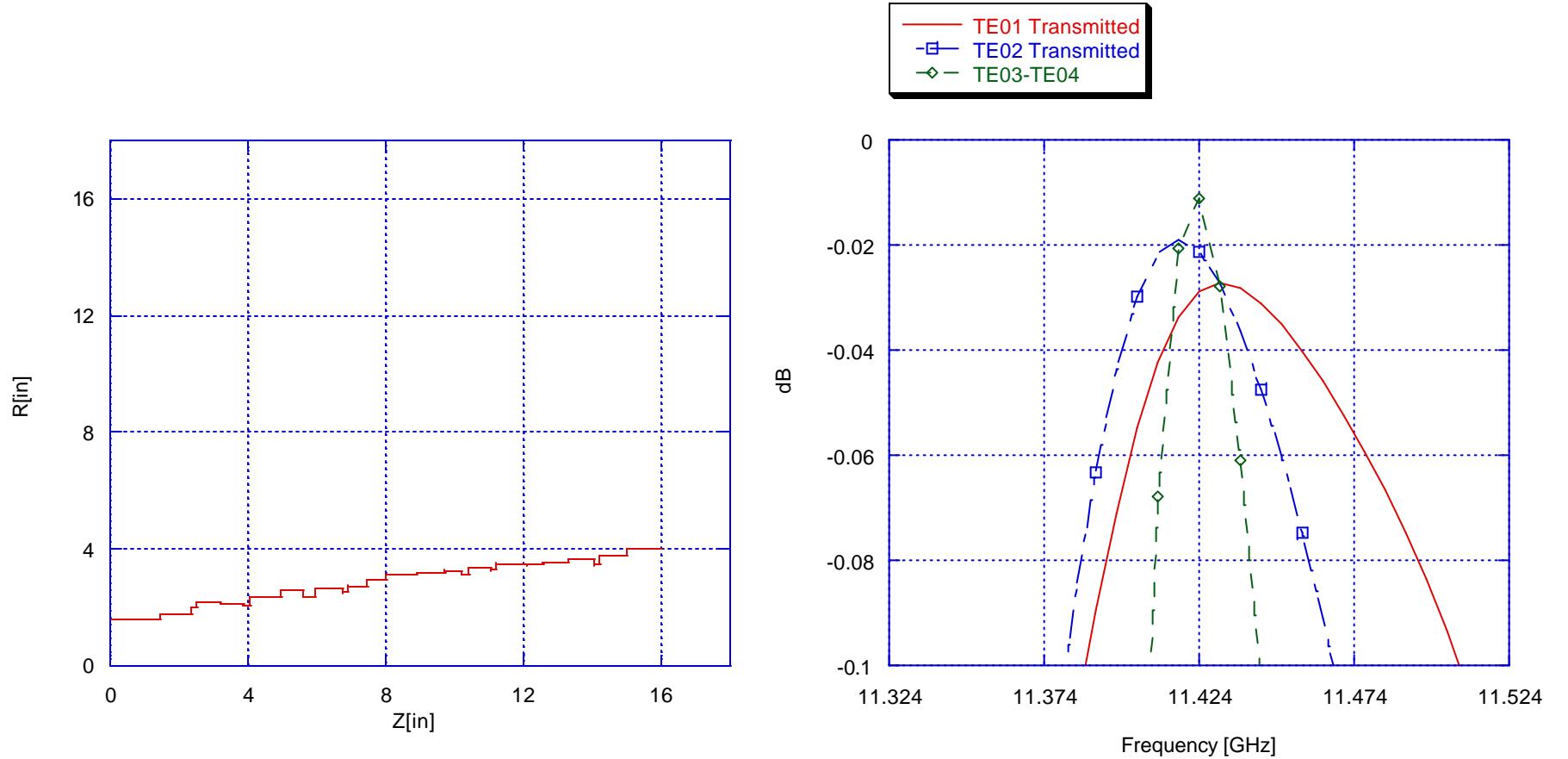




End Taper (before the TE_{01} - TE_{02} Mode converter)

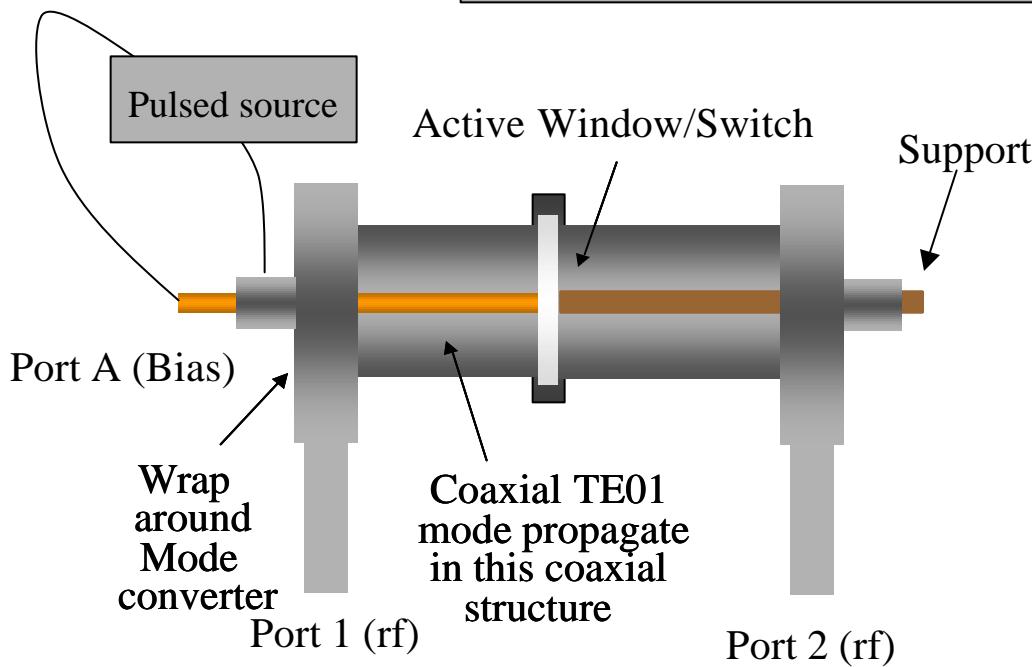
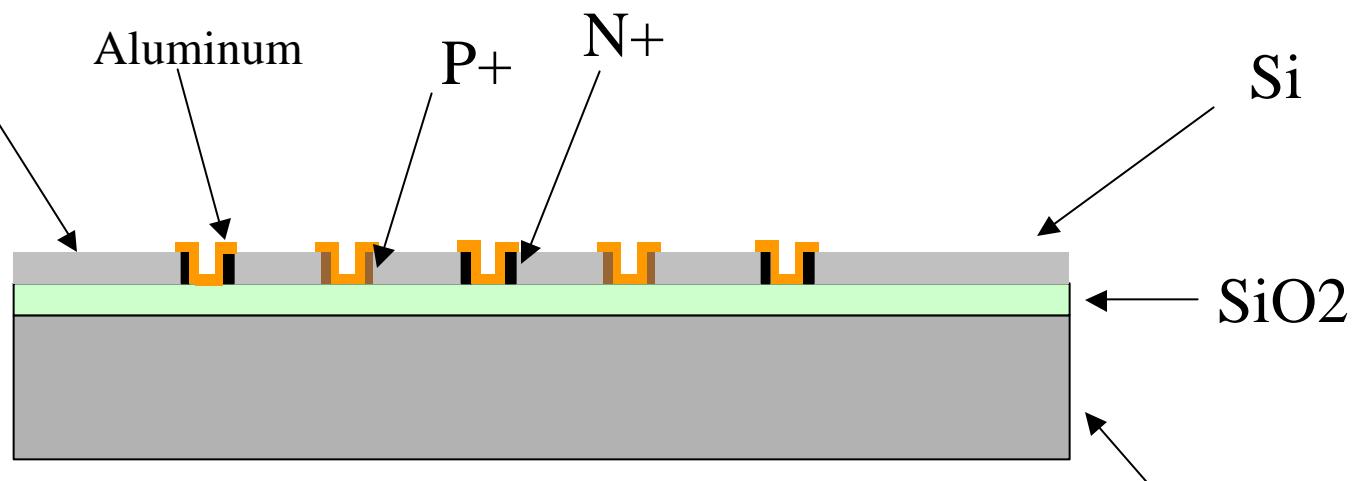


Input taper for a 4-mode system

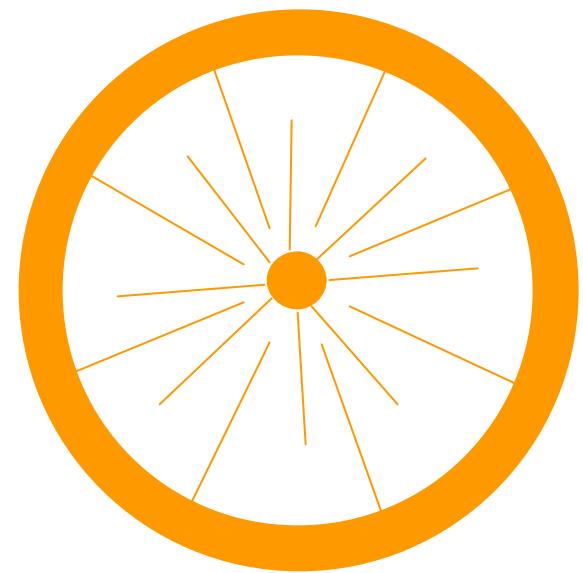


End taper for a 4-Mode System

Device Layer (40 microns thick)

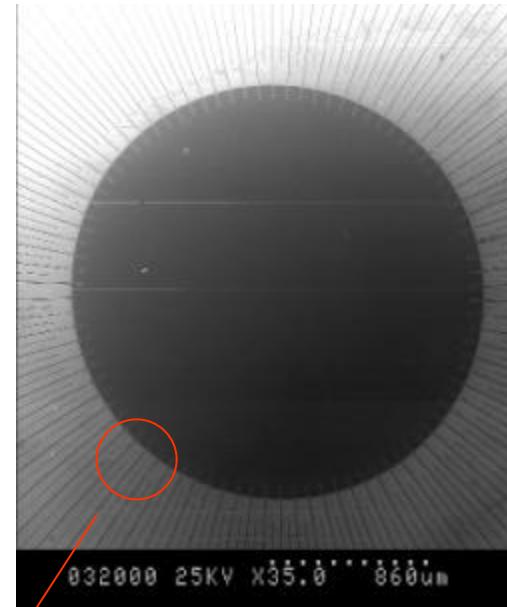
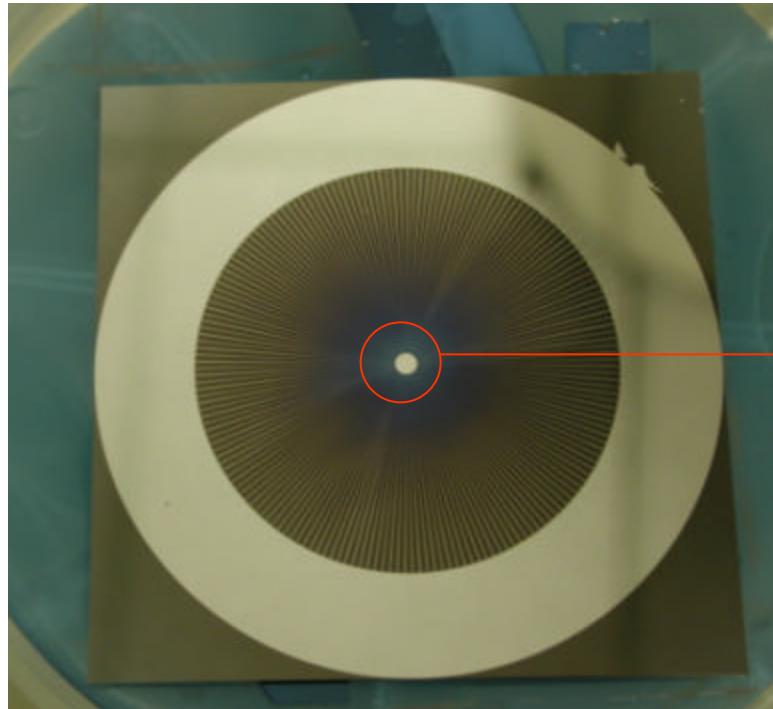


Si Substrate (300 micron thick)

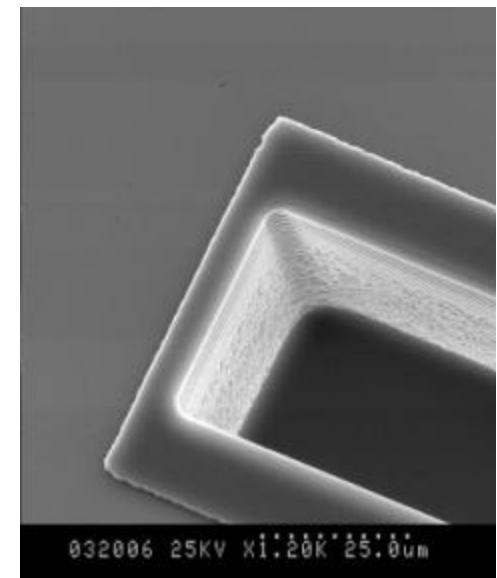
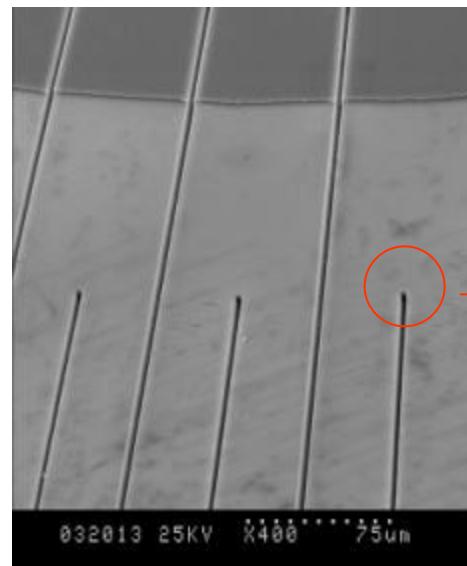


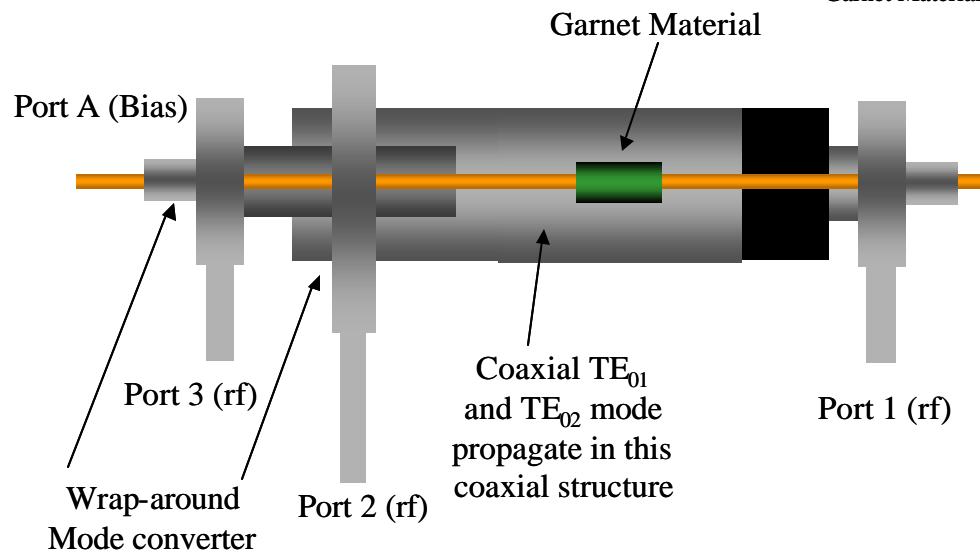
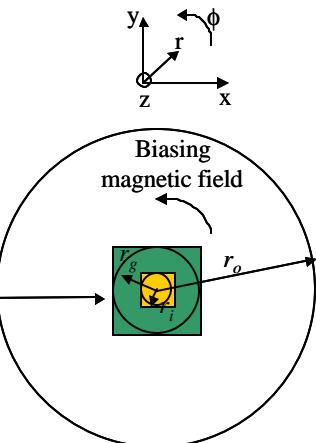
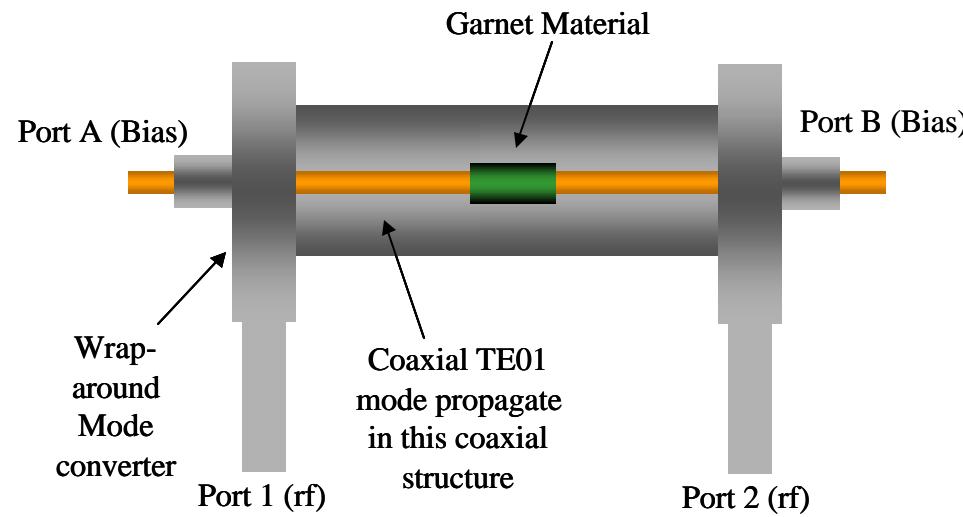
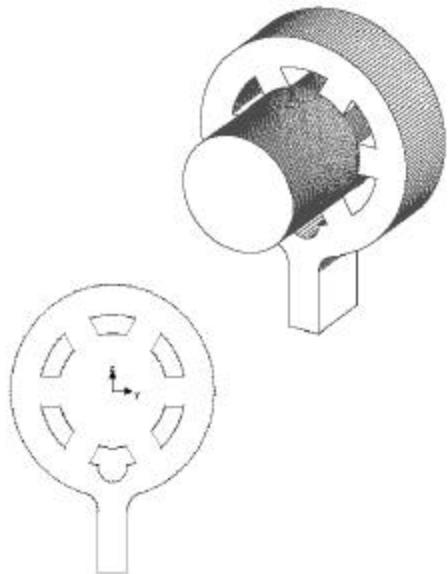
The real Device Contains
180 PIN Diodes

New Switch Configuration

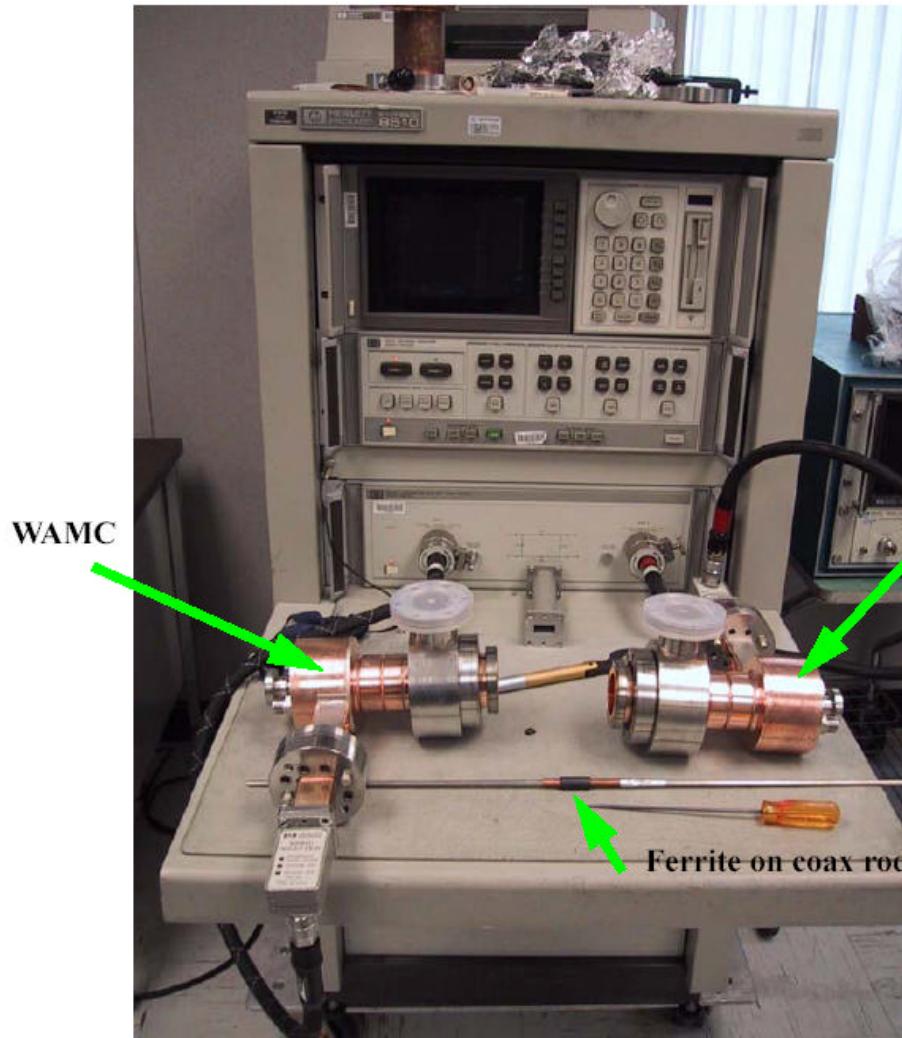


The structure of the new thin wafer RF Switch

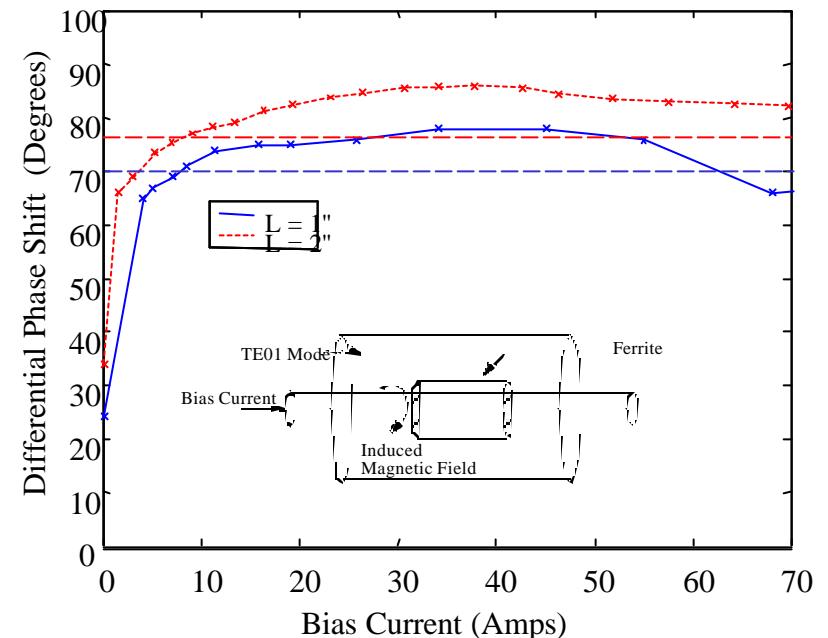




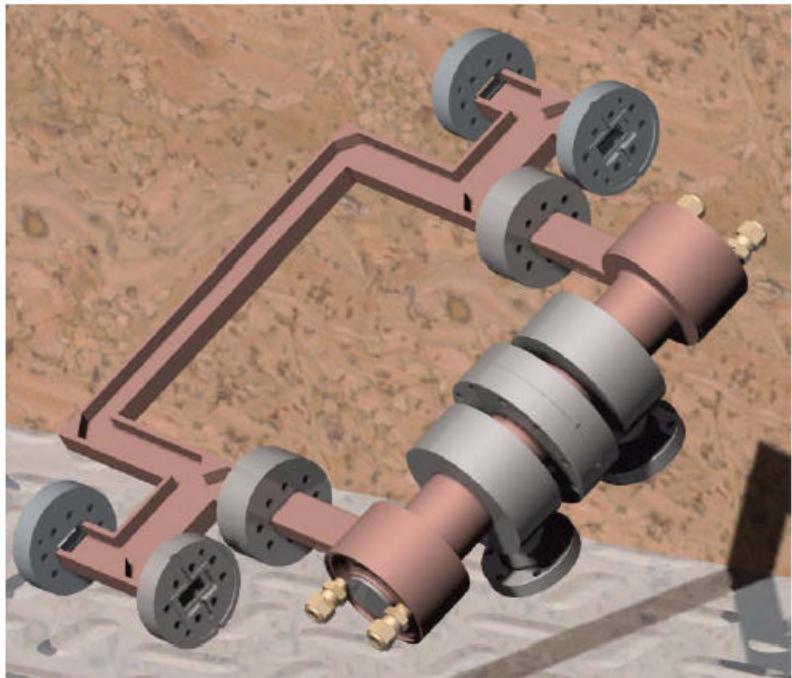
Wrap-Around Mode
Converter for Tap-off, and
extraction, tested to 470 MW



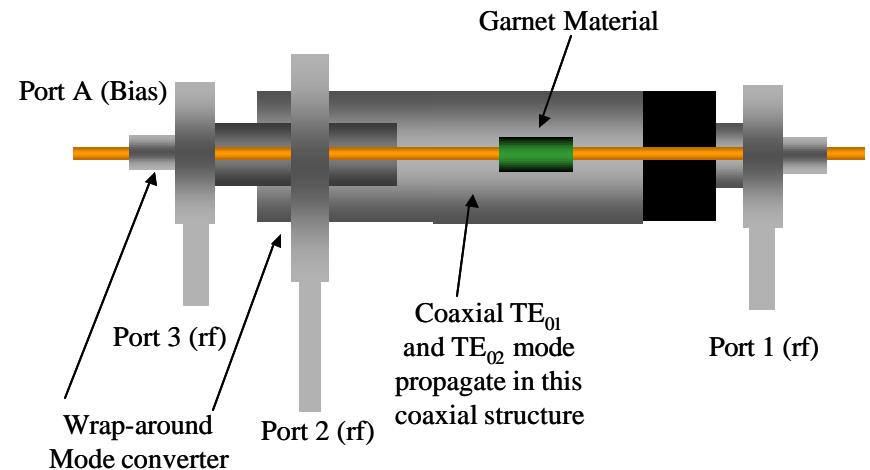
Setup for measurement of differential phase shift in ferrite on inner coax rod.



Measurement of 0.080" Thick Garnet. Dashed lines are HFSS calculation
(analytic calculation predicts 85 degrees)



Rendering of circulator composed of two “H” hybrids and nonreciprocal phase shift section.
Cover of the hybrid section is removed.



An elegant way to synthesis the hybrid as an integrated part of the device.

High Power Circulator/Switch

Summary

- Although most of the rf designs have been completed, we are still perfecting some of the details. In particular the distance between components need to be adjusted.
- A set of cold tests are planned to verify and tune the performance of these devices.